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Customer's Approval

Issue:Nov.19,2019

This product is under development and specifications are subject to change.

Specifications for

Blanview TFT-LCD Monitor(TENTATINE)

(7.0" WVGA 800 x RGB x 480 Landscape)

Version 0.0
(Please be sure to check the specifications latest version.)

MODEL COM70H7M40ULC

Signature:
Name:
Section:
Γitle:
Date:
USTECH
TOPPAN PRINTING CO.,LTD.

Electronics Division

Ortus Subdivision

Approved by

Checked by

Prepared by

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1. Application

This Specification is applicable to 178 mm (7.0 inch) Blanview TFT-LCD monitor for non-military use.

- © TOPPAN PRINTING makes no warranty or assume no liability that use of this Product and/or any information including drawings in this Specification by Purchaser is not infringing any patent or other intellectual property rights owned by third parties, and TOPPAN PRINTING shall not grant to Purchaser any right to use any patent or other intellectual property rights owned by third parties. Since this Specification contains TOPPAN PRINTING's confidential information and copy right, Purchaser shall use them with high degree of care to prevent any unauthorized use, disclosure, duplication, publication or dissemination of TOPPAN PRINTING's confidential information and copy right.
- ① If Purchaser intends to use this Products for an application which requires higher level of reliability and/or safety in functionality and/or accuracy such as transport equipment (aircraft, train, automobile, etc.), disaster-prevention/security equipment or various safety equipment, Purchaser shall consult TOPPAN PRINTING on such use in advance.
- This Product shall not be used for application which requires extremely higher level of reliability and/or safety such as aerospace equipment, telecommunication equipment for trunk lines, control equipment for nuclear facilities or life-support medical equipment.
- ① It must be noted as an mechanical design manner, especial attention in housing design to prevent arcuation/flexureor caused by stress to the LCD module shall be considered.
- TOPPAN PRINTING assumes no liability for any damage resulting from misuse, abuse, and/or miss-operation of the Product deviating from the operating conditions and precautions described in the Specification.
- It shall be mutually conferred if nonconforming defect which result from unspecified cause in this specification arises.
- ① If any issue arises as to information provided in this Specification or any other information, TOPPAN PRINTING and Purchaser shall discuss them in good faith and seek solution.
- TOPPAN PRINTING assumes no liability for defects such as electrostatic discharge failure occurred during peeling off the protective film or Purchaser's assembly process.

This Product is compatible for RoHS(2.0) directive.

Object substance	Maximum content [ppm]
Cadmium and its compound	100
Hexavalent Chromium Compound	1000
Lead & Lead compound	1000
Mercury & Mercury compound	1000
Polybrominated biphenyl series (PBB series)	1000
Polybrominated biphenyl ether series (PBDE series)	1000
Bis(2-ethylhexyl)phthalate series(DEHP series)	1000
Butyl benzyl phthalate series(BBP series)	1000
Dibutyl phthalate series(DBP series)	1000
Diisobutyl phthalate series(DIBP series)	1000

2. Outline Specifications

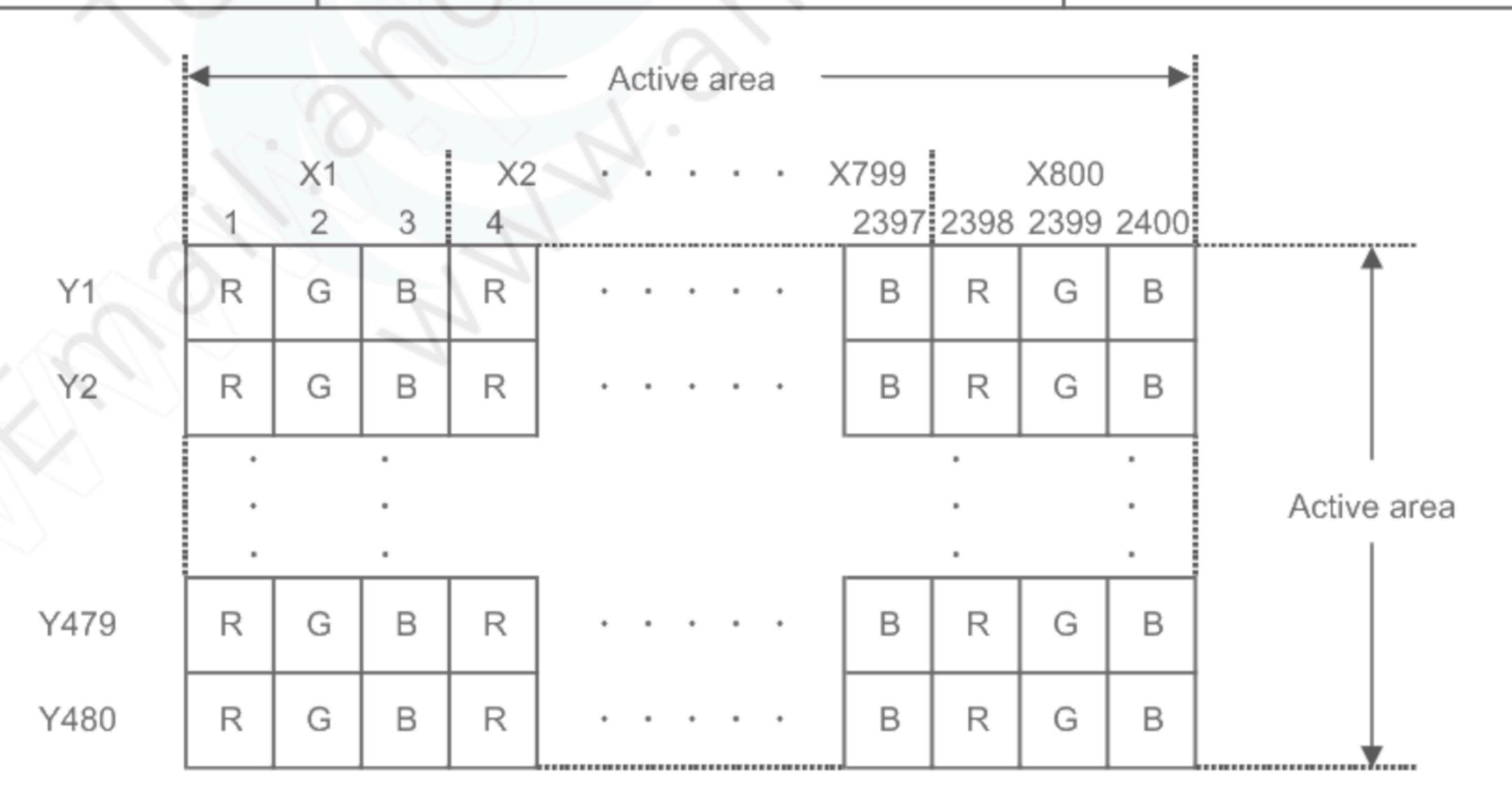
2.1 Features of the Product

- 7.0 inch diagonal display, 800 x RGB [H] x 480 [V] dots.
- 16.7 M colors (8-bit) / 262 K colors (6-bit).
- 3.3V voltage single power source.
- Timing generator [TG], Counter-electrode driving circuitry, Built-in power supply circuit.
- Long life & High bright white LED back-light.
- Blanview TFT-LCD, improved outdoor readability.



2.2 Display Method

Items	Specifications	Remarks
Display type	VA 16.7 M colors. / 262 K colors.	
	Blanview, Normally black.	
Driving method	a-Si TFT Active matrix.	
	Line-scanning, Non-interlace.	
Dot arrangement	RGB stripe arrangement.	Refer to "Dot arrangement"
Signal input method	8-bit / 6-bit LVDS interface (VESA format)	
Backlight type	Long life & High bright white LED.	
NTSC ratio	50%	



Dot arrangement (FPC cable placed down side)

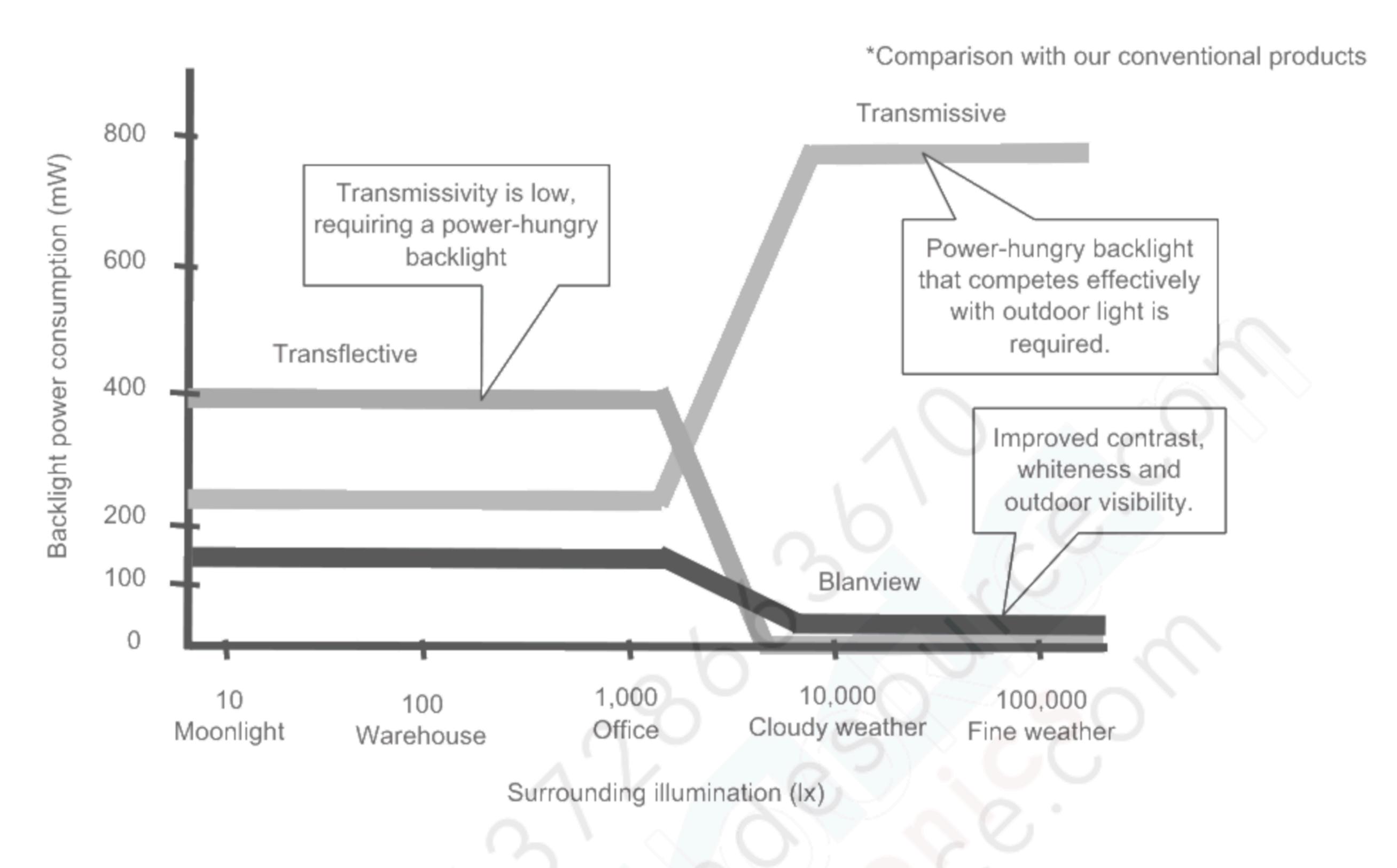
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<Features of Blanview>

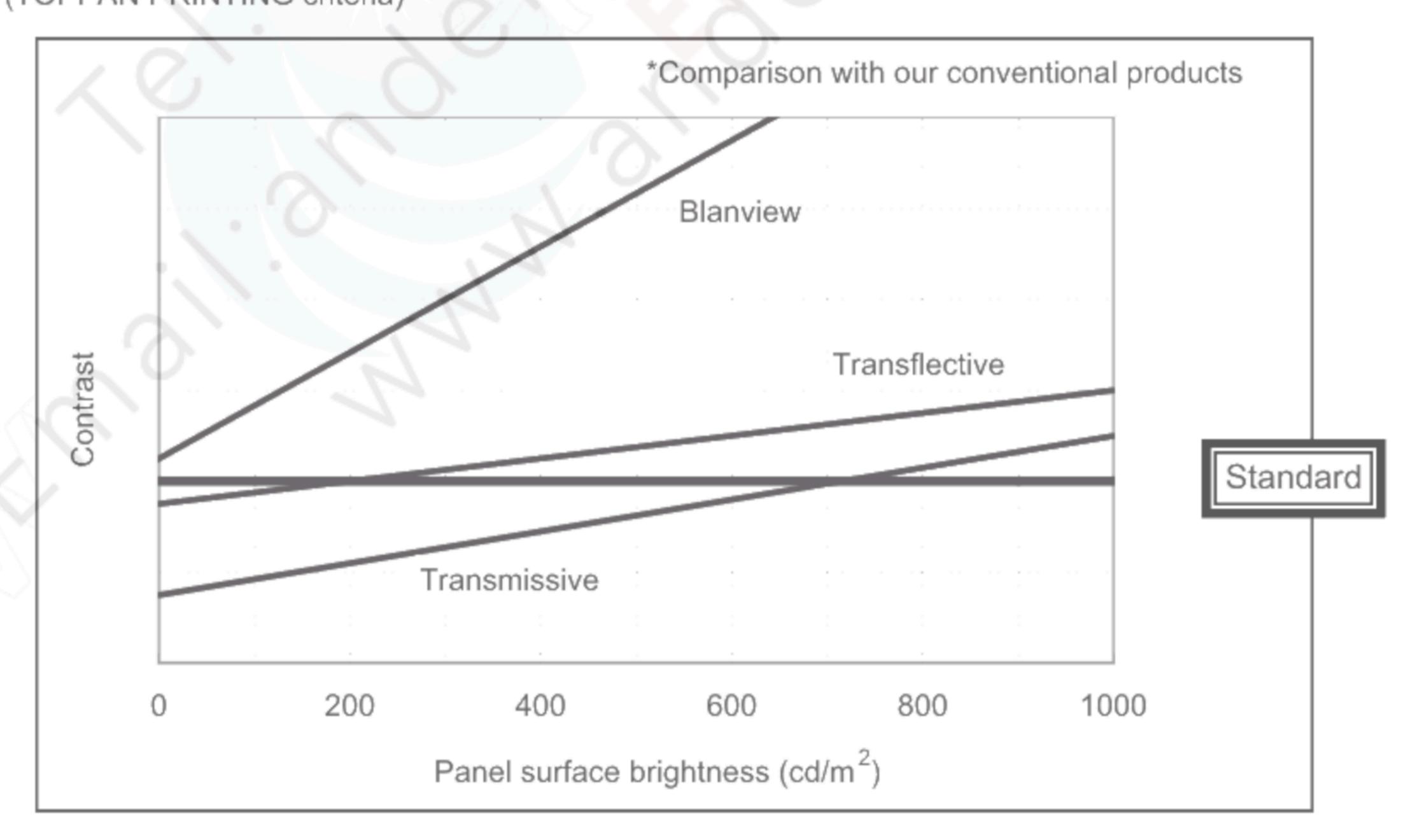
- Backlight power consumption required to assure visibility. (equivalent to 3.5"QVGA)



- Contrast characteristics under 100,000lx. (same condition as direct sunlight.)

With better contrast (higher contrast ratio), Blanview TFT-LCD has the best outdoor readability in three different types of TFT-LCD.

Below chart shows contrast value against panel surface brightness. (Horizontal: Panel surface brightness/ Vertical: Contrast value) LCD panel has enough outdoor readability above our Standard line. (TOPPAN PRINTING criteria)



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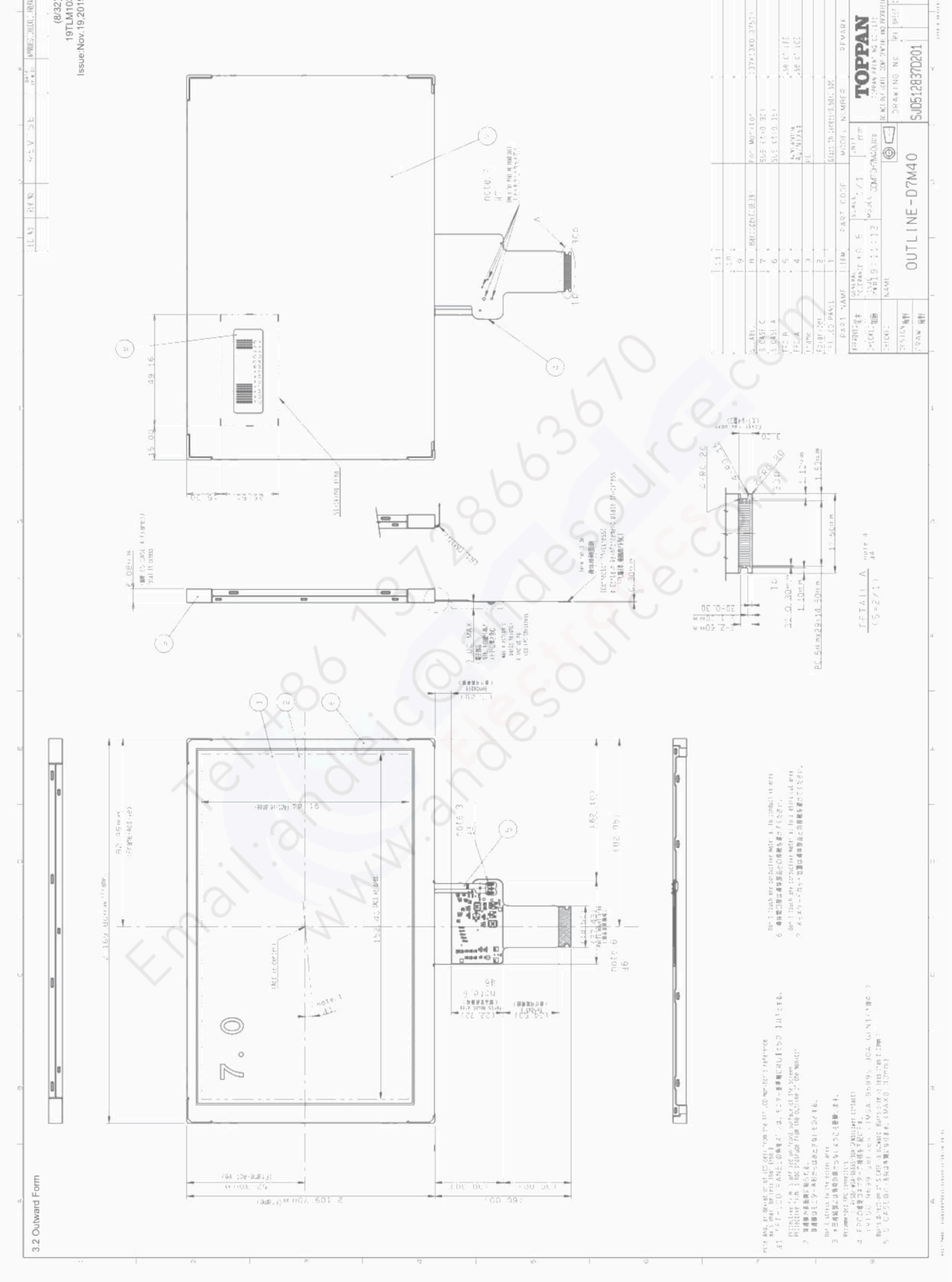
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3. Dimensions and Outward Form

3.1 Dimensions

Items	Specifications	Unit	Remarks
Outline dimensions	169.80[H] × 109.70[V] × 6.08 [D]		Exclude FPC cable and
			parts on FPC.
Active area	152.40[H] × 91.44[V]	mm	178mm diagonal
Number of dots	2400[H] × 480[V]	dot	
Dot pitch	63.5[H] × 190.5[V]	um	
Surface hardness of the polarizer	3	Н	Load:4.9N
Weight	TBD	g	Include FPC cable



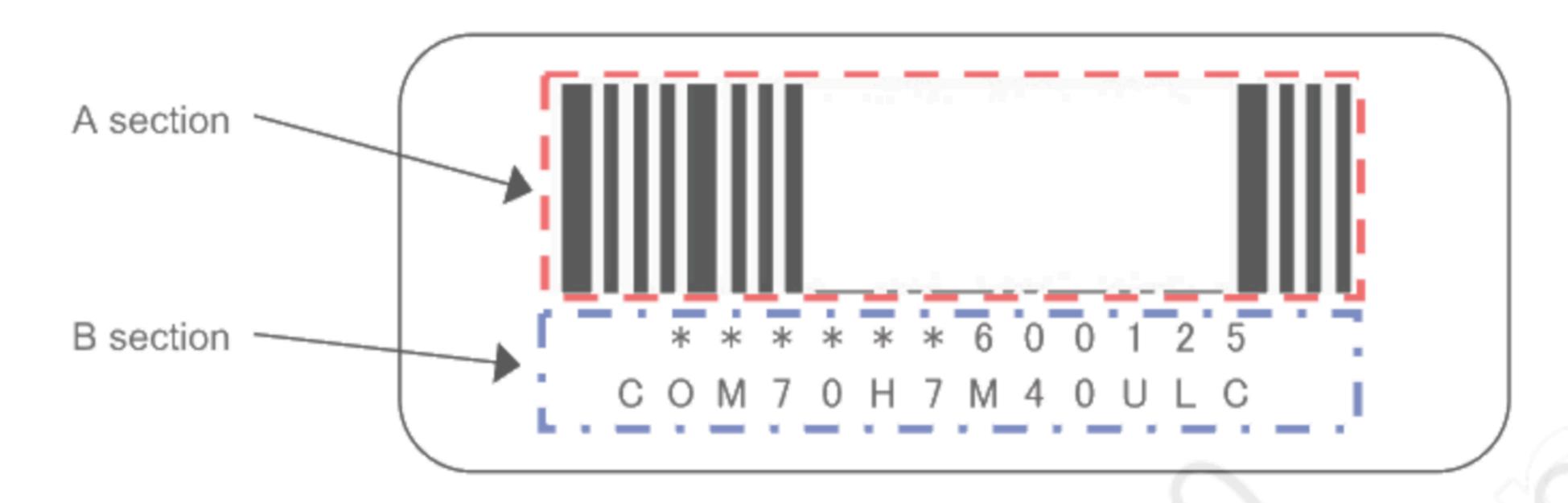
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3.3 Serial Label (S-LABEL)

Indication

A section : Bar code

B section: Combination of a character



Details of B section

Upper column: It indicates the least significant digit of manufacture year (1 digit), manufacture month with below alphabet (1letter), model code (5characters), serial number (6digits).

	Contents of display		0					
а	The least significant	digit of m	anufacture	year				
b	Manufacture month	Jan-A	Mar-C	May-E	Jul-G	Sep-I	Nov-K	
	Ivianufacture month	Feb-B	Apr-D	Jun-F	Aug-H	Oct-J	Dec-L	
С	Model code 70AMC (Made in Japan)							
		70ANC	(Made in Ma	alaysia)				
d	Serial number		(COV)					

- * Example of indication of Serial label (S-label)
- Made in Japan

9L70AMC600125

means "manufactured in Desember 2019, 7" AM type, C specifications, serial number 600125"

Made in Malaysia

9L70ANC600125

means "manufactured in Desember 2019, 7" AN type, C specifications, serial number 600125"

Lower column: Model (13characters)

2) Location of Serial Label (S-label)

Refer to 3.2 "Outward Form".

Others

Bar code readability is excluded from quality assurance coverage.

4. Pin Assignment

No.	Symbol	Function					
1	BLH	LED drive power source. (Anode side)					
2	BLL2	LED drive power source . (Cathode side 2)					
3	BLL1	LED drive power source . (Cathode side 1)	Р				
4	GND	Ground	Р				
5	VDD	Power supply input.	Р				
6	VDD	Power supply input.	Р				
7	TEST1	TEST input (Connect to VDD)	I				
8	TEST2	TEST input (Connect to GND)					
9	TEST3	TEST input (Connect to GND)					
10	NC	No connection					
11	UL/DR	Up & Left / Down & Right switching terminal (Low : DR , High or NC : UL)	// I				
12	IM	6 / 8 bit (based on VESA) switching terminal (Low: 6bit, High or NC: 8bit)					
13	STBYB	Standby signal (Low:Standby operation,High:Normal operation)	ı I				
14	GND	Ground	Р				
15	R0-	LVDS DATA0(-)	I				
16	R0+	LVDS DATA0(+)	I				
17	GND	Ground	Р				
18	R1-	LVDS DATA1(-)	Ι				
19	R1+	LVDS DATA1(+)	I				
20	GND	Ground	Р				
21	CLK-	LVDS CLK(-)					
22	CLK+	LVDS CLK(+)					
23	GND	Ground	Р				
24	R2-	LVDS DATA2(-)					
25	R2+	LVDS DATA2(+)					
26	GND	Ground	Р				
27	R3-	LVDS DATA3(-)					
28	R3+	LVDS DATA3(+)					
29	GND	Ground	Р				
30	NC	No connection	_				

- Recommended connector: IRISO ELECTRONICS 9699 series [IMSA-9699S-30A-GFN1]
- Please be sure to check a consistency between pin assignment in "3.2 Outward Form" and your connector pin assignment when designing your circuit.
 Inconsistency in input signal assignment may cause a malfunction.
- Since FPC cable has gold plated terminals, gilt finish contact shoe connector is recommended.

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5. Absolute Maximum Rating

GND=0V

Item	Symbol Condition		Ra	ting	Unit	Applicable terminal
Ittorri	Oyiiiboi	Condition	MIN	MAX	OTTIL	Арриоавіс (сітпінаі
Supply voltage	VDD		-0.3	3.9	V	VDD
Input voltage for logic	VI		-0.3	VDD+0.3	V	UL/DR, IM, STBYB
Forward current	IL1,IL2			TBD	mA	BLH-BLL1/BLL2
Storage temperature range	Tstg		-40	95	°C	

6. Recommended Operating Conditions

GND=0V

Item	Symbol	Condition	Rating			Unit	Applicable terminal
ITOILI	Syllibol	Condition	MIN	TYP	MAX	Otilic	Applicable terminal
Supply voltage	VDD		3.0	3.3	3.6	V	VDD
Input voltage for logic	VI		0		VDD	V	UL/DR , IM , STBYB
Operational temperature range	Тор	Note1	-30	+25	+85	°C	Panel surface temperature

Note1: This monitor is operatable in this temperature range. With regard to optical characteristics, refer to Item 9."CHARACTERISTICS".

7. Electrical Characteristics

7.1 DC Characteristics

(Unless otherwise noted, Ta=25 °C, VDD=3.3V, GND=0V)

Item Symbol		Condition		Rating		Unit	Applicable terminal	
Item	Symbol	Condition	MIN	TYP	MAX	Offic	Applicable terrilinal	
High Level Input Voltage	VIH		0.7VDD	_	VDD	V	UL/DR,IM,STBYB	
Low Level Input Voltage	VIL		0	_	0.3VDD	V		
Pull up/down	RI		200	350	850	kΩ	Pull up : IM , STBYB	
resistor			100	175	425	kΩ	Pull up : UL/DR	
Operating Current	IDD	Color Bar fclk = 27.2 MHz	_	38	76	mA	VDD	

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(BackLight)

(Descripting)									
Item	Symbol	Condition	Rating			Unit	Applicable terminal		
ILCIII	Syllibol	Condition	MIN	TYP	MAX	Offic	Applicable terrilinal		
Forward current	IL1	Ta=25 °C Nota1		(20)	TBD	mA	BLH - BLL1		
	IL2	Ta=25 °C , Note1		(20)	TBD	mA	BLH - BLL2		
Forward voltage	VF1	Ta=25 °C		(18.5)	TBD	V	BLH - BLL1		
*Reference value	VF2	IL1=IL2=(20)mA		(18.5)	TBD	V	BLH - BLL2		
Estimated Life of		Ta=25 °C Note2		(50,000)	(50,000)	hrs			
LED		IL1=IL2=(20)mA							

Note1: - Please control so that each current does not vary (IL1 = IL2).

Note2: - The lifetime of the LED is defined as a period till the brightness of the LED decreases to the half of its initial value.

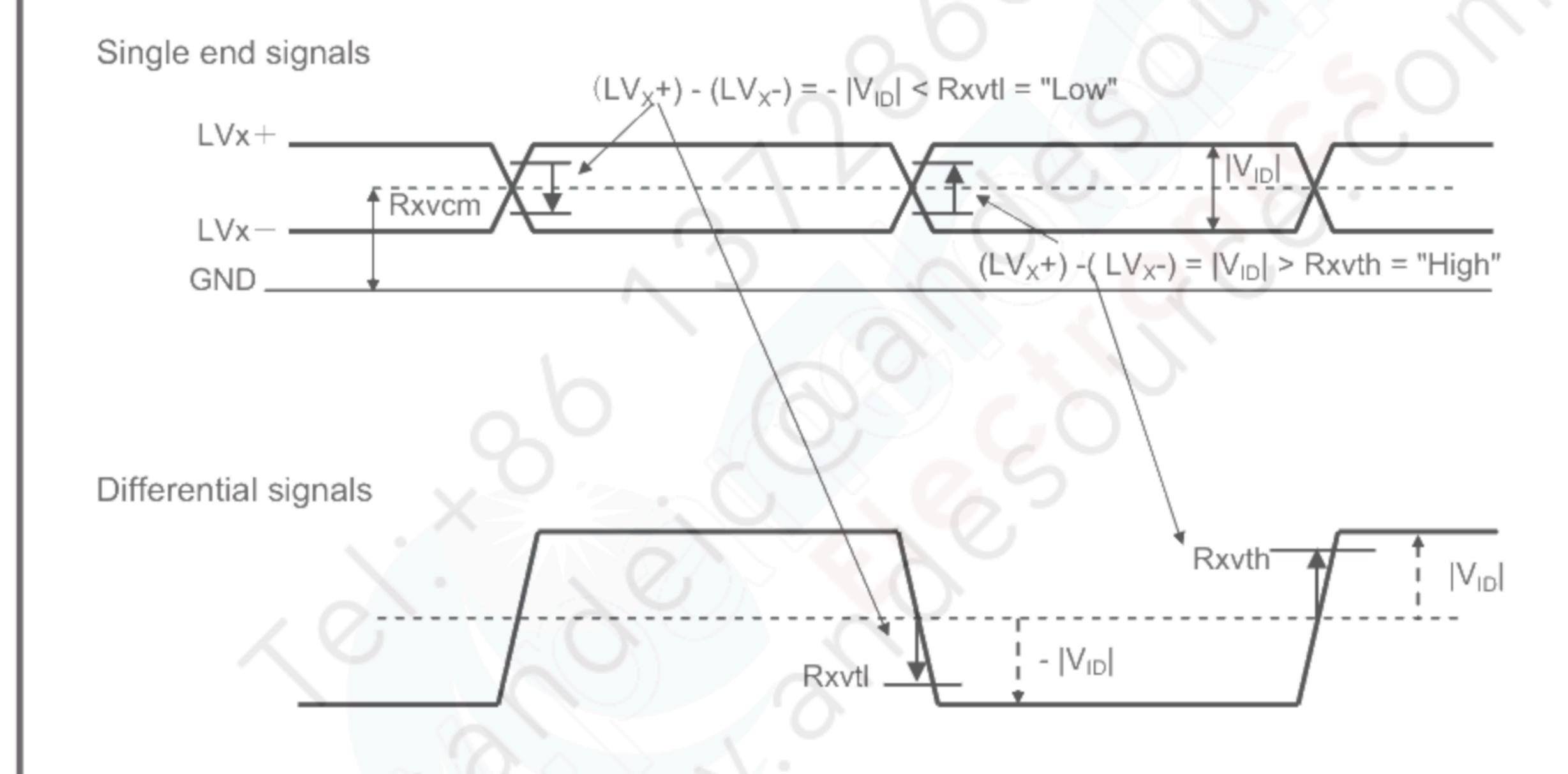
- This figure is given as a reference purpose only, and not as a guarantee.
- This figure is estimated for an LED operating alone.
 As the performance of an LED may differ when assembled as a monitor together with a TFT panel due to different environmental temperature.
- Estimated lifetime could vary on a different temperature and usually higher temperature could reduce the life significantly.

7.2 LVDS interface

7.2.1 LVDS DC Characteristics

(Unless otherwise noted, Ta=25 °C, VDD=3.3V, GND=0V)

							. , , , , , , , , , , , , , , , , , , ,
ltem	Item Symbol Condition Rating					Unit	Applicable terminal
ILEIII	Syllibol	Condition	MIN	TYP	MAX	Offic	Applicable terrilinal
Differential input high threshold voltage	Rxvth	Rxvcm=1.2V	-	-	0.1	V	CLK+, CLK- R0+, R0-, R1+, R1-
Differential input low threshold voltage	Rxvtl		-0.1	4	_	٧	R2+, R2-, R3+, R3-
Differential input common Mode voltage	Rxvcm		1.0	1.2	1.8- Vid /2	٧	
Differential input voltage	V _{ID}		0.2	-	0.6	٧	
Differential input leakage current	RV _{leak}		-10	- 6	+10	μΑ	



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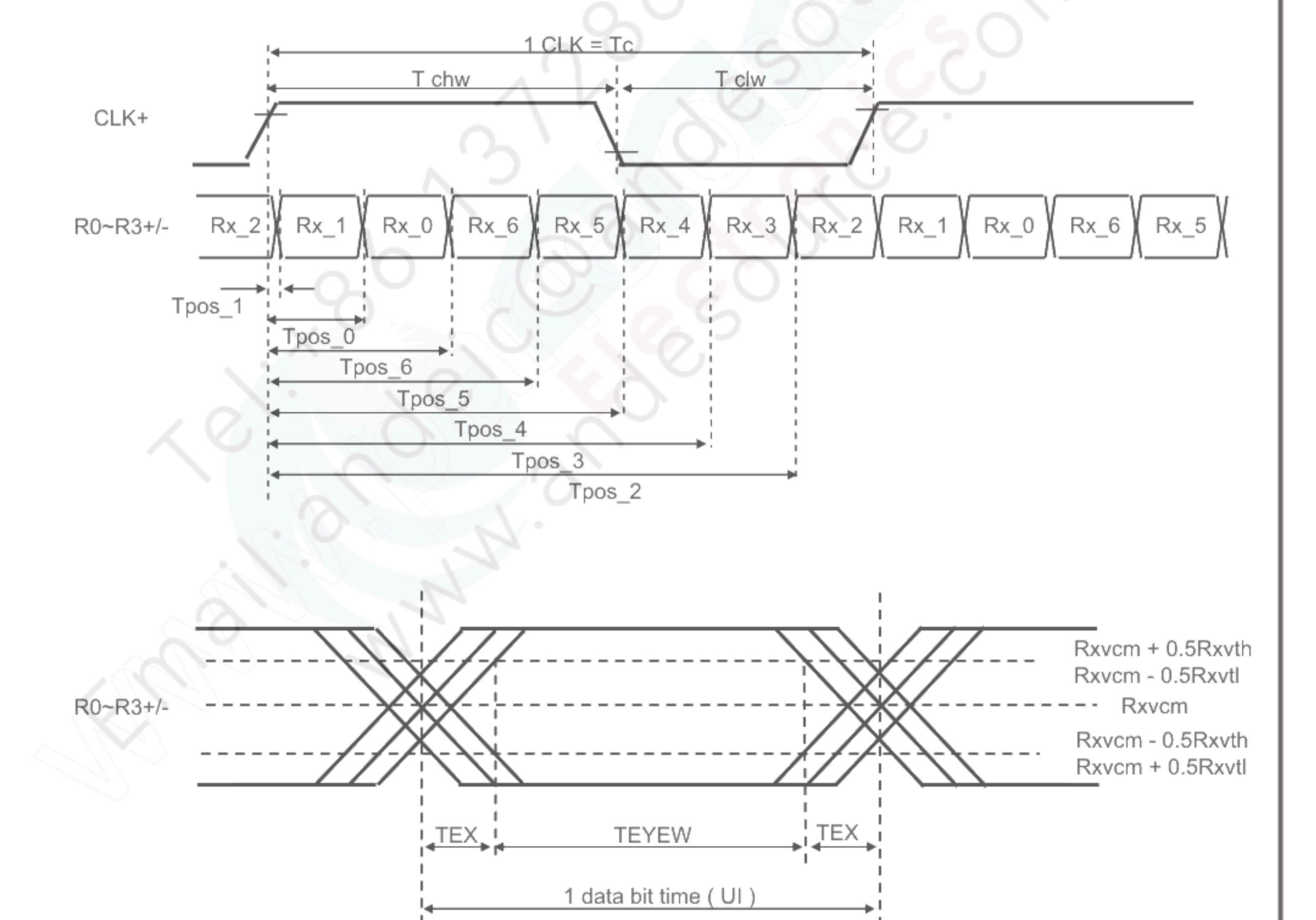
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7.2.2 LVDS AC Characteristics

(Unless otherwise noted, Ta=25 °C, VDD=3.3V, GND=0V)

ltom	Symbol		Rating		Linit	
ltem	Symbol	MIN	TYP	MAX	Unit	
CLK Frequency	f clk	25.2	27.2	30.5	MHz	
Clock period	Тс	32.8	36.8	39.7	ns	
1 data bit time	UI	-	1/7	-	Тс	
CLK High level Width	T chw	2.9	4	4.1	UI	
CLK Low level Width	T clw	2.9	3	4.1	UI	
Position 1	Tpos_1	-0.2	0	0.2	UI	
Position 0	Tpos_0	0.8	1	1.2	UI	
Position 6	Tpos_6	1.8	2	2.2	UI	
Position 5	Tpos_5	2.8	3	3.2	UI	
Position 4	Tpos_4	3.8	4	4.2	UI	
Position 3	Tpos_3	4.8	5	5.2	UI	
Position 2	Tpos_2	5.8	6	6.2	UI	
Reciever Strobe Position 7	TEYEW	0.6	-		UI	<i>}</i>
Reciever Strobe Position 8	TEX	-		0.2	UI	



15/32) Issue:Nov.19,2019 SPECIFICATIONS № 19TLM103 7.2.3 LVDS Data Format VESA Format 8bit * (MSB : R[7],G[7],B[7]) CLK+ CLK-R0+ R[5] R[4] R[3] R[2] R[0] R[0] G[0] G[0] R[1] R[1] R0-R1+ G[1] B[0] G[5] G[4] G[3] G[1] G[2] B[1] G[2] B[1] R1-R2+ ENAB) B[2] ENAB B[2] HDB[5] B[3] B[4] B[3] R2-R3+ R[6] B[7] G[6] R[7] R[7] B[6] G[7] R[6] R3-Next cycle Current cycle Previous cycle VESA Format 6bit * (MSB : R[5],G[5],B[5]) CLK+ CLK-R0+ R[4] R[1] R[0] R[5] R[2] R[0]G[0] G[0] R[3] R0-R1+ G[1] G[3] G[5] G[4] G[1] B[1] G[2] B[1] G[2] B[0] R1-R2+ B[2] **ENAB** B[4] B[2] **ENAB** B[3] HDB[5] B[3] R2-R3+ R3-Previous cycle Next cycle Current cycle TOPPAN PRINTING CO.,LTD.

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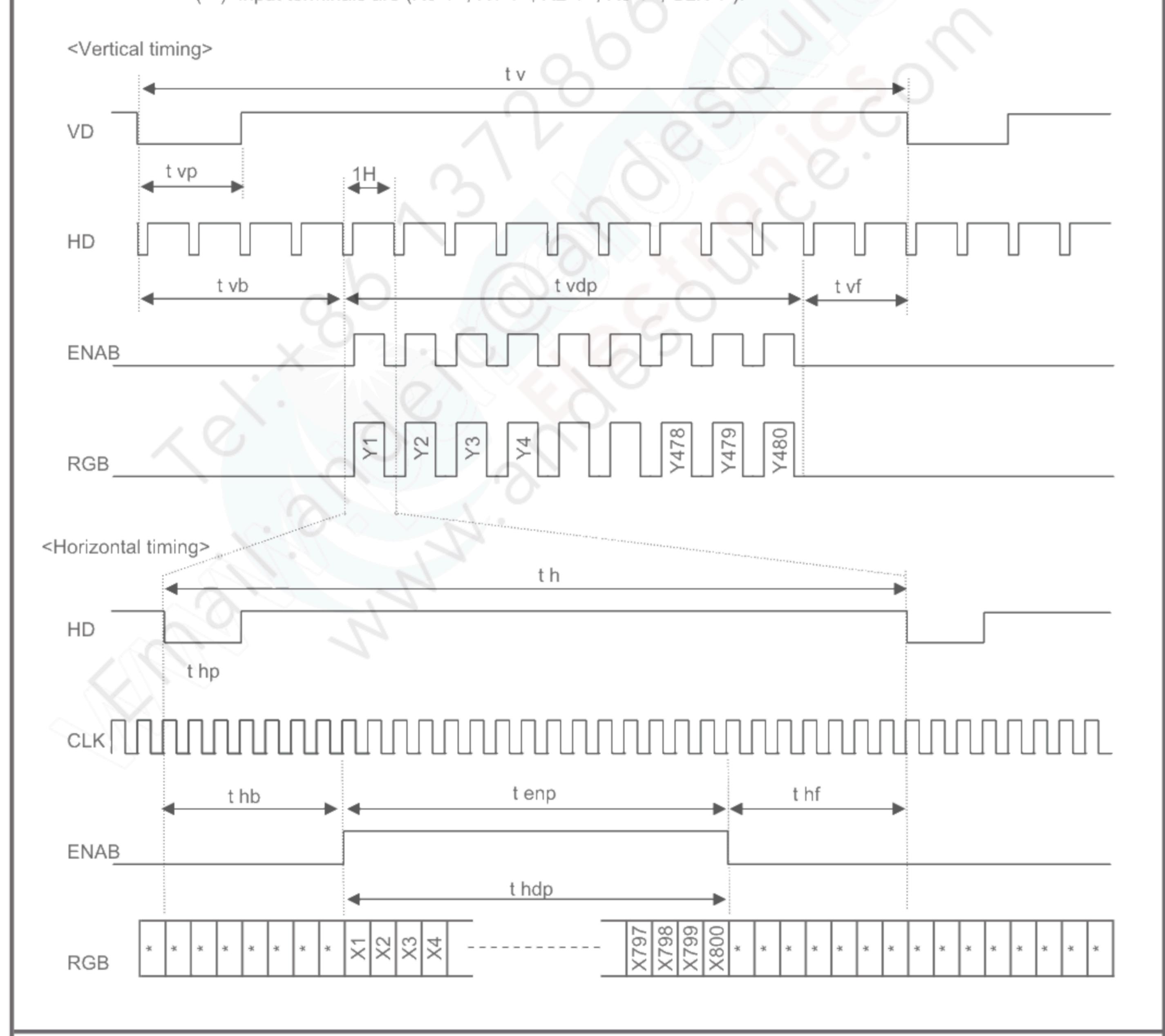
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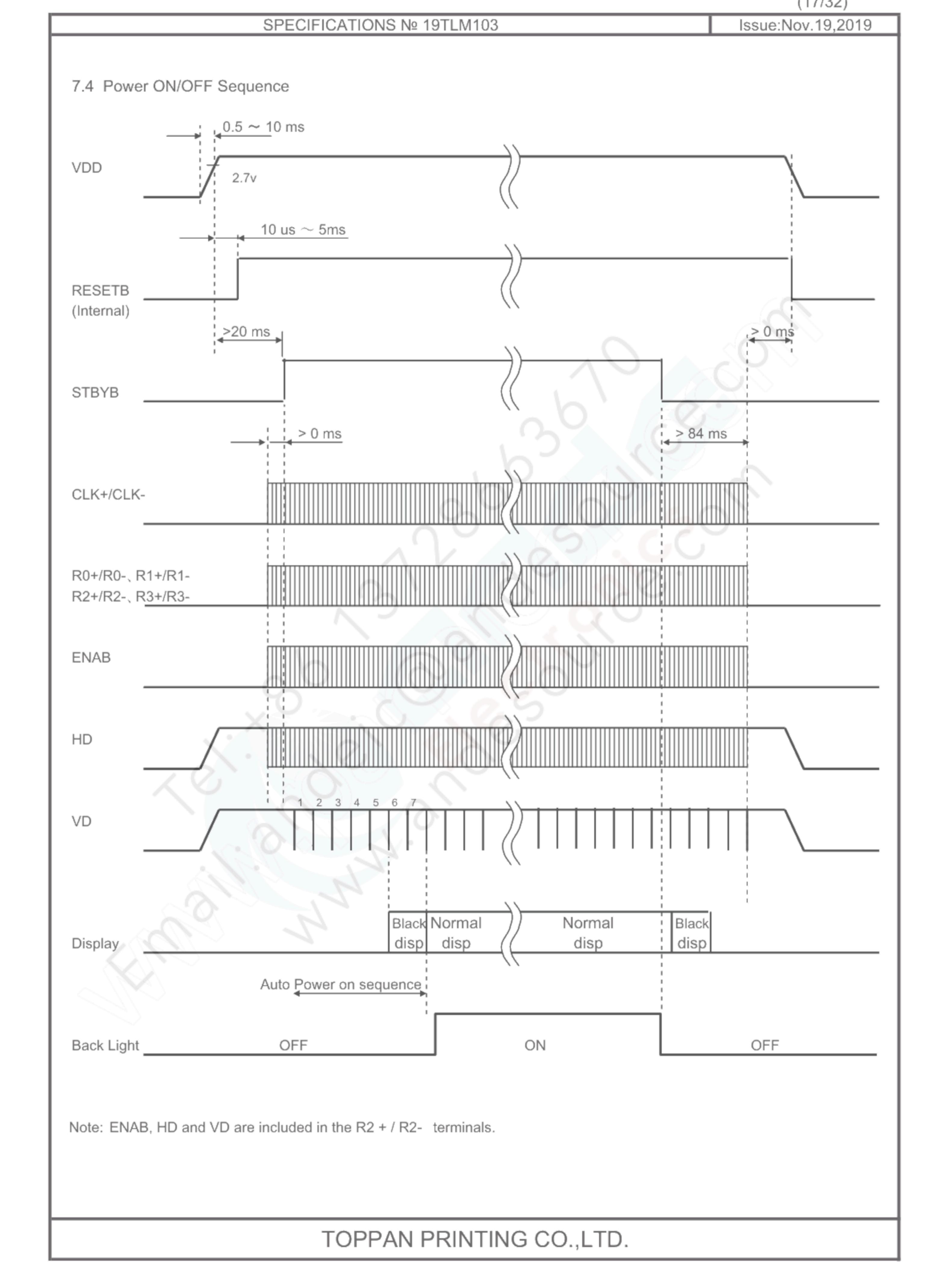
Issue:Nov.19,2019

7.3 Input timing

ltem	Symbol	Rating				Signal (*)
Item	Sylliboli	MIN	TYP	MAX	Unit	Signal ()
CLK frequency	fCLK	25.2	27.2	30.5	MHz	CLK
VD frequency	fVD	-	60	-	Hz	VD
1 vertical field	tv	490	528	552	Н	1
VD pulse width	tvp	1	2	66	Н	1
VD back porch	tvb	5	10	67	Н	VD,HD,ENAB
VD front porch	tvf	5	38	67	Н	R[7:0],G[7:0],B[7:0]
Vertical valid data	tvdp		480		Н	1
HD frequency	fHD	_	28.8	_	kHz	HD
1 horizontal field	th	856	860	920	CLK	
HD pulse width	thp	1	2	100	CLK	
HD back porch	thb	5	16	101	CLK	CLK,HD,ENAB
HD front porch	thf	19	44	115	CLK	R[7:0],G[7:0],B[7:0]
ENAB pulse width	tenp		800	1	CLK	
Horizontal valid data	thdp		800		CLK	

(*) Input terminals are (R0+/-, R1+/-, R2+/-, R3+/-, CLK+/-).

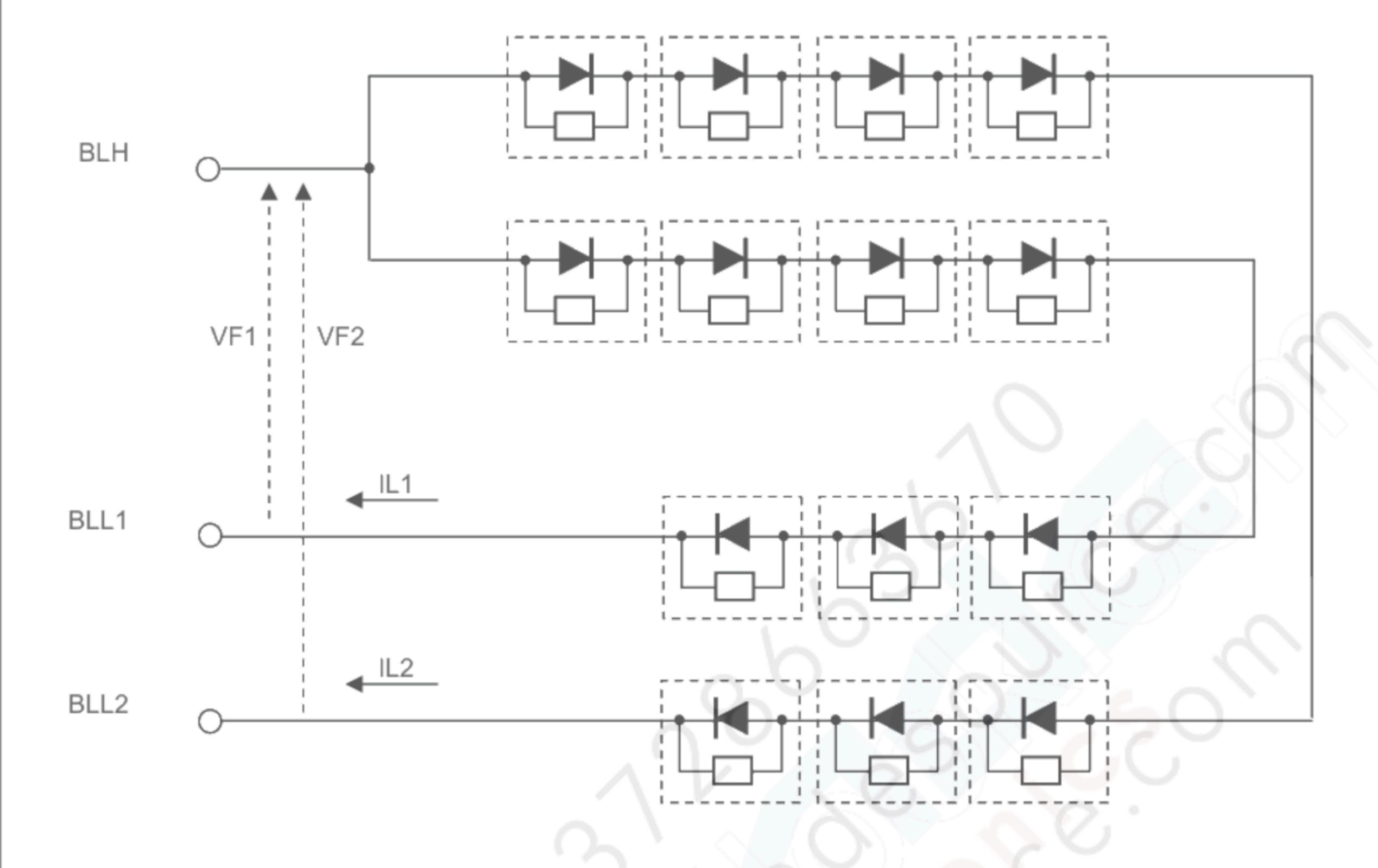


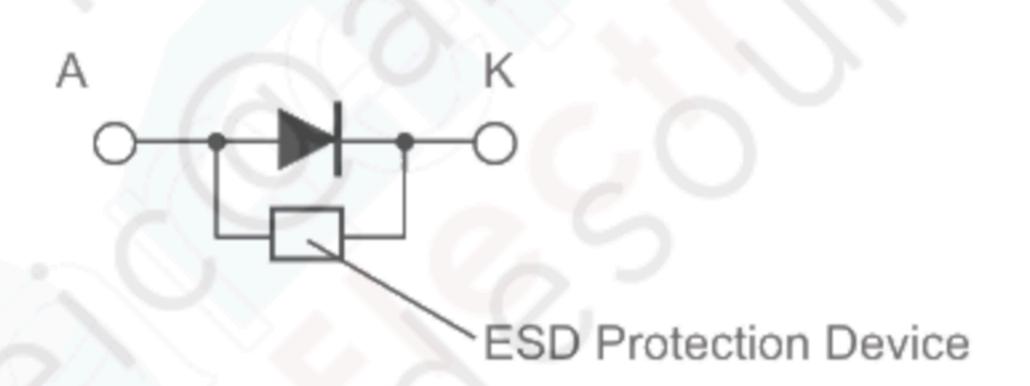


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8. LED Circuit





* It is recommended to control currents of BLL1 / BLL2 to equal current values (IL1 = IL2).

Characteristics

9.1 Optical Characteristics

< Measurement Condition >

Measuring instruments: CS2000 (KONICA MINOLTA), LCD7200 (OTSUKA ELECTRONICS),

EZcontrast160D (ELDIM)

Driving condition: VDD=3.3V,GND=0V

Optimized VCOMDC

Backlight: IL1=IL2=(20)mA

Measured temperature: Ta=25° C

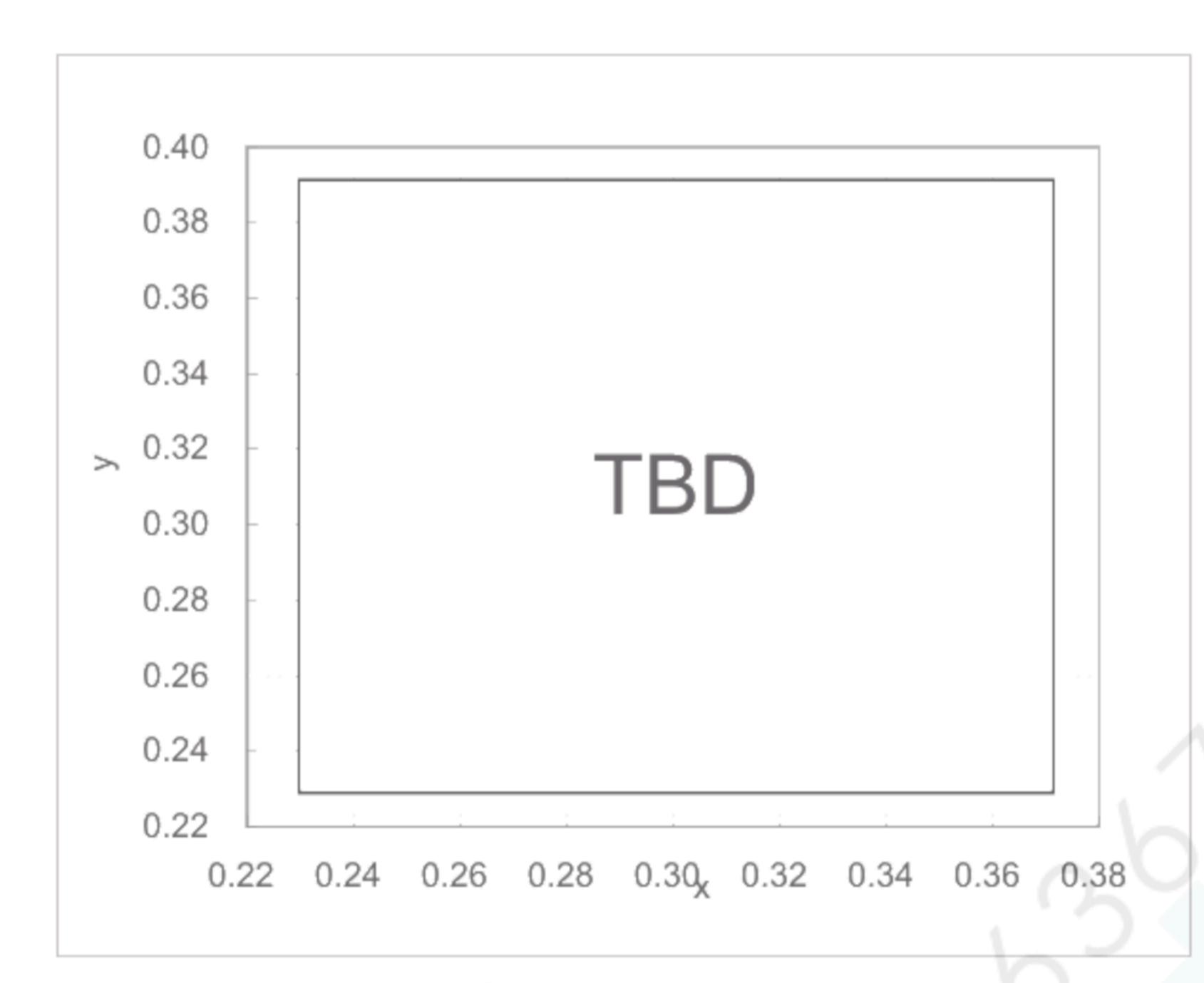
	Item	Symbol	Condition	MIN	TYP	MAX	Unit	Note No.	Remark
Response	Rise time + Fall time		[Data]= 00h→FFh [Data]= FFh→00h		(50)	(100)	ms	1	
ntrast	Backlight ON	CR	[Data]= FFh / 00h	(350)	(700)	Ô		2	
Contr	Backlight OFF			_	(3)	0			
	Left	θL	[Data]=	(80)	(C		deg	3	
/iewing angle	Right	θR	FFh / 00h	(80)			deg		
/iev	Up	φU	CR≧10	(80)		-//	deg		
	Down	φD		(80)	-	60%	deg		
White	Chromaticity	Х	[Data]=FFh	White ch	romaticit	ty range		4	
VVIIILE	Cilionaticity	У							
	Burn-in			be ob	served a	irn-in ima after 2 hou tern displ	urs of	5	
Cente	er brightness		[Data]=FFh		(800)	Gi C	cd/m ²	6	IL1=IL2=(45)mA
				TBD	(400)	5			IL1=IL2=(20)mA
Brigh	tness distribution	on	[Data]=FFh	70	(-)	-	%	7	

^{*} Note number 1 to 7: Refer to the APPENDIX of "Reference Method for Measuring Optical Characteristics".

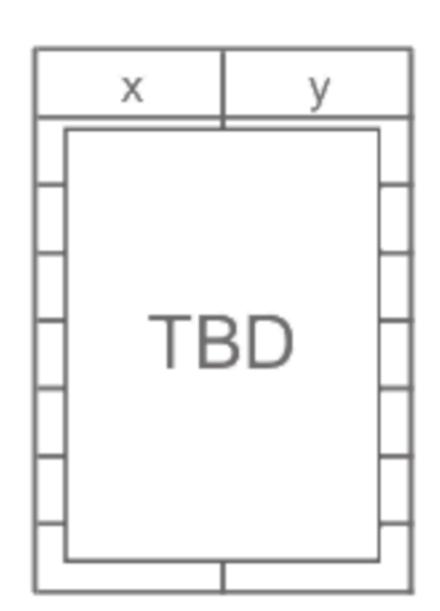
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[White Chromaticity Range]



White Chromaticity Range

9.2 Temperature Characteristics

< Measurement Condition >

Measuring instruments: CS2000 (KONICA MINOLTA), LCD7200 (OTSUKA ELECTRONICS)

Driving condition: VDD=3.3V, GND=0V

Optimized VCOMDC

Backlight: IL1=IL2=(20)mA

ltom	Item			Specification	Remark	
петт			MIN	TYP	MAX	
		(6)	(200)			Ta=-30°C
Contrast	ratio	CR	(200)			Backlight ON
Contrast	atio	(200)	-		Ta=85°C	
				(200)		Backlight ON
Response time	Rise time	TON +		(980)ms	(1500)ms	Ta=-30°C
rvesponse unie	Fall time TOF	TOFF	-	(40)ms	(80)ms	Ta=85°C
Display Q	Display Quality		No noticeable display defect or ununiformity should be observed.			

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Criteria of Judgment

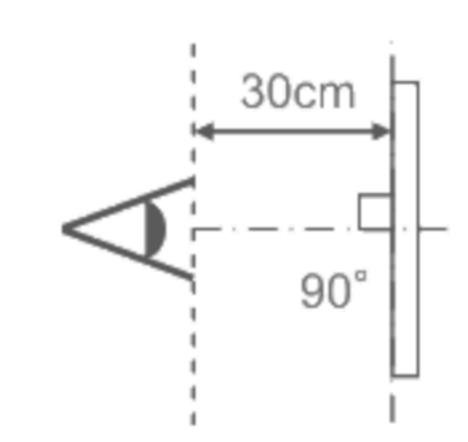
10.1 Defective Display and Screen Quality

Test Condition: Observed TFT-LCD monitor from front during operation

with the following conditions

Driving Signal Raster Pattern (RGB, white, black) Signal condition [Data]:00h, 94h, FFh (3steps)

Observation distance 30 cm Illuminance 200 to 350 lx Backlight IL1=IL2=(20)mA



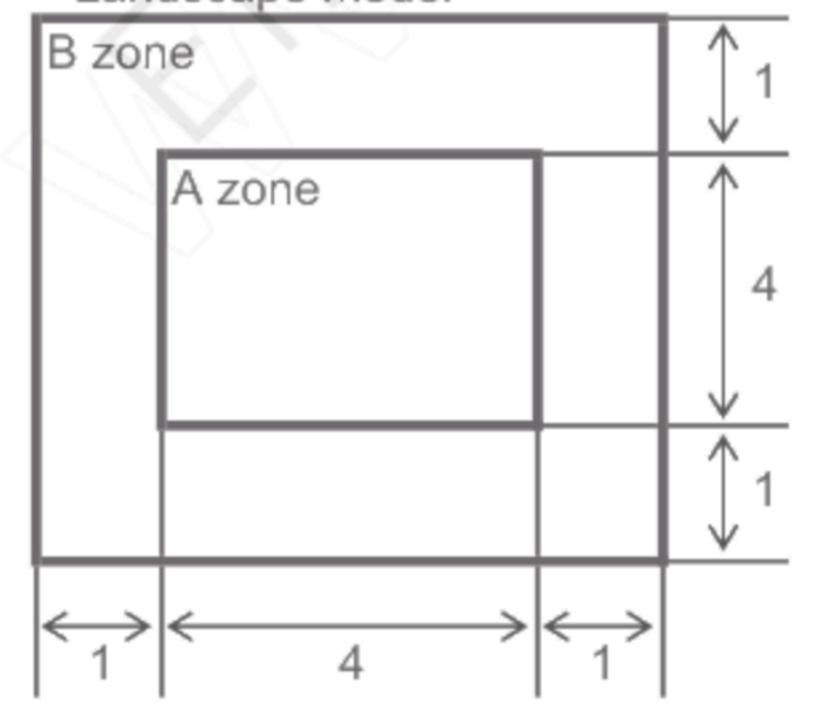
D	efect item		Defect content	Criteria		
	Line defect	Black, white or	color line, 3 or more neighboring defective dots	Not exists		
Display Quality	Uneven bright of the control of the		Visible through 2% ND filter at [Data]=00h Visible through 5% ND filter at [Data]=00h ar dark through white display at [Data]=94h	Refer to table 1		
Ш			n 5% ND filter at [Data]=00h	Acceptable		
	Dirt	Uneven brightne	ess (white stain, black stain etc)	Invisible through 5% ND filter at Black screen. Invisible through 1% ND filter at other screen.		
ξ		Point-like	0.25mm< φ	N=0		
ual			0.20mm< ϕ ≤0.25mm	N≦2		
	Foreign		φ ≤0.20mm	Acceptable		
reer	particle	Liner	3.0mm <length 0.08mm<width<="" and="" td=""><td>N=0</td></length>	N=0		
Sci			length≤3.0mm or width≤0.08mm	Acceptable		
	Others			Use boundary sample for judgment when necessary		

φ(mm): Average diameter = (major axis + minor axis)/2 Permissible number: N

Table 1

Area	High bright dot	Low bright dot	Dark	Total	Criteria
Α	0	2	2	3	Permissible distance between same color bright dots (includes neighboring dots): 3 mm or more
В	2	4	4	6	Permissible distance between same color high bright dots (includes neighboring dots): 5 mm or more
Total	2	4	4	7	

<Landscape model>



Division of A and B areas B area: Active area

Dimensional ratio between A and B areas: 1: 4: 1

(Refer to the left figure)

Division of A and B areas

(ZZ/3Z)

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10.2 Screen and Other Appearance

Testing conditions

Observation distance

Illuminance

30cm

1200~2000 lx

	Item	Criteria	Remark
	Flaw	Ignore invisible defect when the backlight is on.	Applicable area:
zer	Stain		Active area only
Polarizer	Bubble		(Refer to the section
Pol	Dust		3.2 "Outward form")
	Dent		
	S-case	No functional defect occurs	
	FPC cable	No functional defect occurs	

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11. Reliability Test

. Reli	ability Test		, ,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,		
	Test item	Test condition	number of failures		
			/number of examinations		
	High temperature storage	Ta=95°C (500)hrs	TBD		
	Low temperature storage	Ta=-40 C (500)hrs	TBD		
	High temperature & high	Ta=60° C, RH=90% (500)hrs	TBD		
+ + +	humidity storage	non condensing **			
test	High temperature operation	Tp=85°C (500)hrs	TBD		
rability	Low temperature operation	Tp=-30 C (500)hrs	TBD		
ap	High temp & humid operation	Tp=40°C, RH=90% (500)hrs	TBD		
Dur	riigir terrip a namia operation	non condensing **			
	Thermal shock storage	-40←→95° C(30min/30min) (100)cycles	TBD		
		Xenon Blackpanel 63±3°C non-shower	TBD		
	Lightfastness	450W/m ² (300~700nm) non-operating			
		Integral dose 800MJ/m ²			
		Confirms to EIAJ ED-4701/300	TBD		
	Electrostatic discharge test	C=200pF,R=0Ω,V=±200V			
	(Non operation)	Each 3 times of discharge on and power supply			
		and other terminals.			
	Curfoso diosborgo tost	C=250pF, R=100Ω, V=±12kV	TBD		
test	Surface discharge test (Non operation)	Each 5 times of discharge in both polarities	12/3/		
	(Non operation)	on the center of screen with the case grounded.			
environmental		Pull the FPC with the force of 3N for 10 sec.	TBD		
Ě	FPC tension test	in the direction - 90-degree to its			
Į.į		original direction.			
env	EDO 11	Pull the FPC with the force of 3N for 10 sec.	TBD		
	FPC bend test	in the direction -180-degree to its			
aníc		original direction. Reciprocate it 3 times.			
Mechanical	V/Shanding Anal	Total amplitude 1.5mm, f=10~55Hz, X,Y,Z	TBD		
Me	Vibration test	directions for each 2 hours			
		Use TOPPAN PRINTING original jig	TBD		
		(see next page)and make an impact with			
	Impact test	peak acceleration of 1000m/s2 for 6 msec with			
		half sine-curve at 3 times to each X, Y, Z directions			
		in conformance with JIS C 60068-2-27-2011.			
4:		Acceleration of 19.6m/s ² with frequency of			
test	Packing vibration-proof test	10→55→10Hz, X,Y, Zdirection for each			
ū		30 minutes			
Packing		Drop from 75cm high.	TBD		
g,	Packing drop test	1 time to each 6 surfaces, 3 edges, 1 corner			

Note:Ta=ambient temperature

Tp=Panel temperature

% The profile of high temperature/humidity storage and High Temperature/humidity operation (Pure water of over $10M\Omega\cdot cm$ shall be used.)

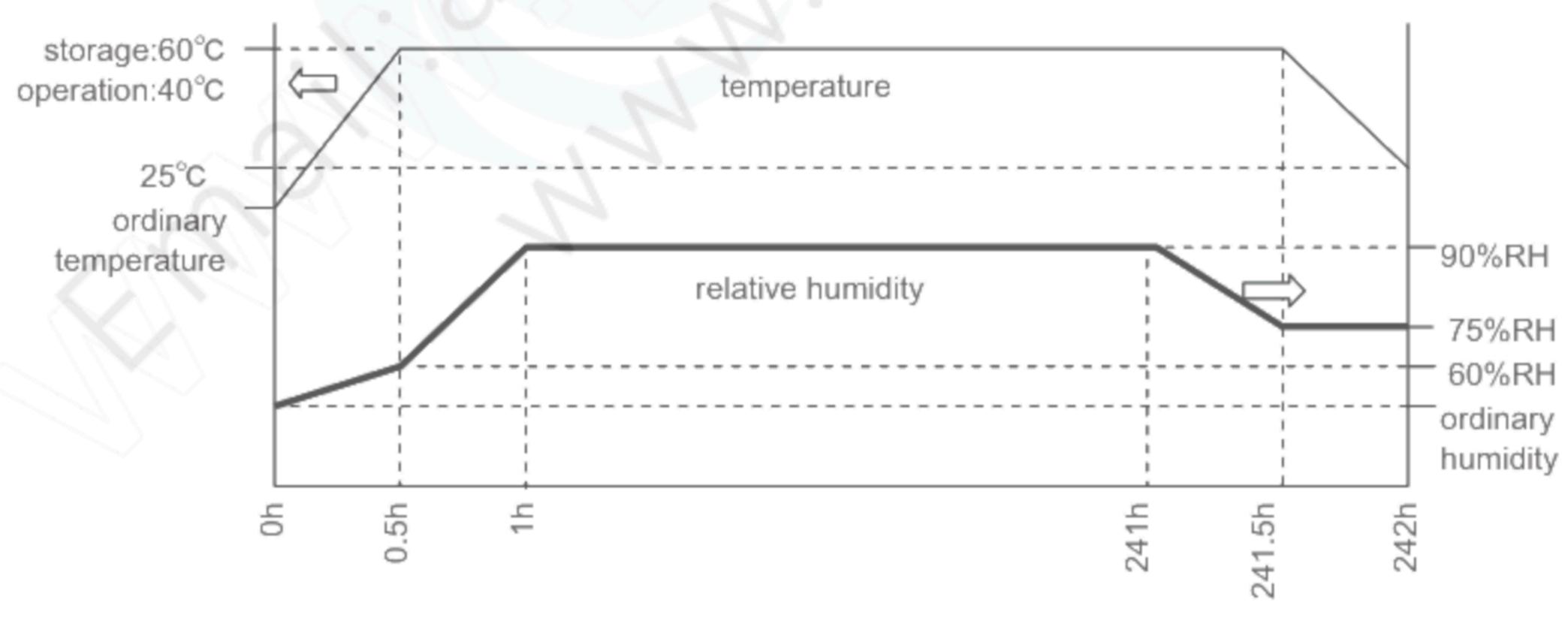


Table2.Reliability Criteria

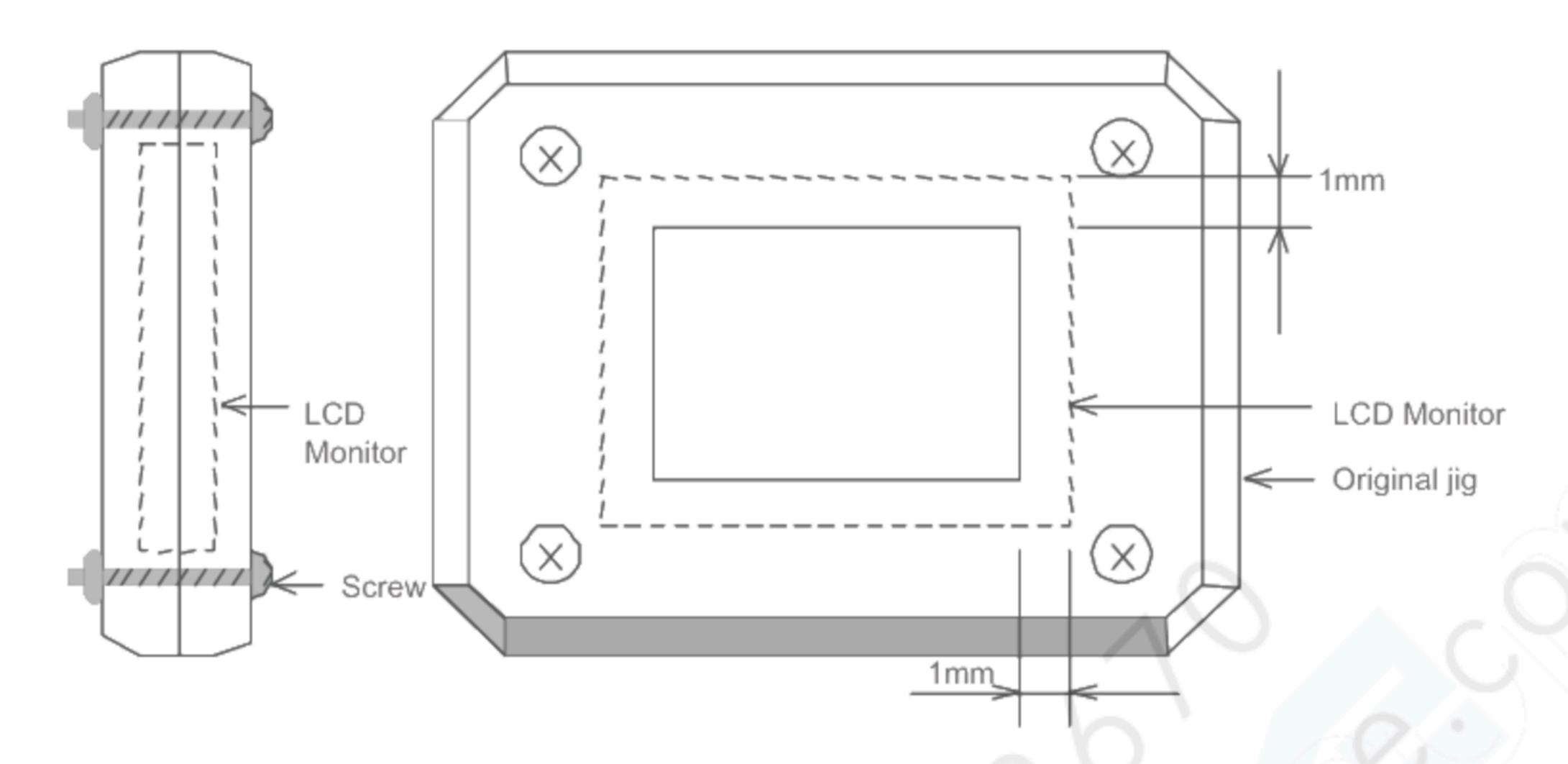
The parameters should be measured after leaving the monitor at the ordinary temperature for 24 hours or more after the test completion.

item	Standard	Remarks
Display quality	No visible abnormality shall be seen.	
	(Except for unevenness by Pol deterioration.)	
Contrast ratio	200 or more	Backlight ON

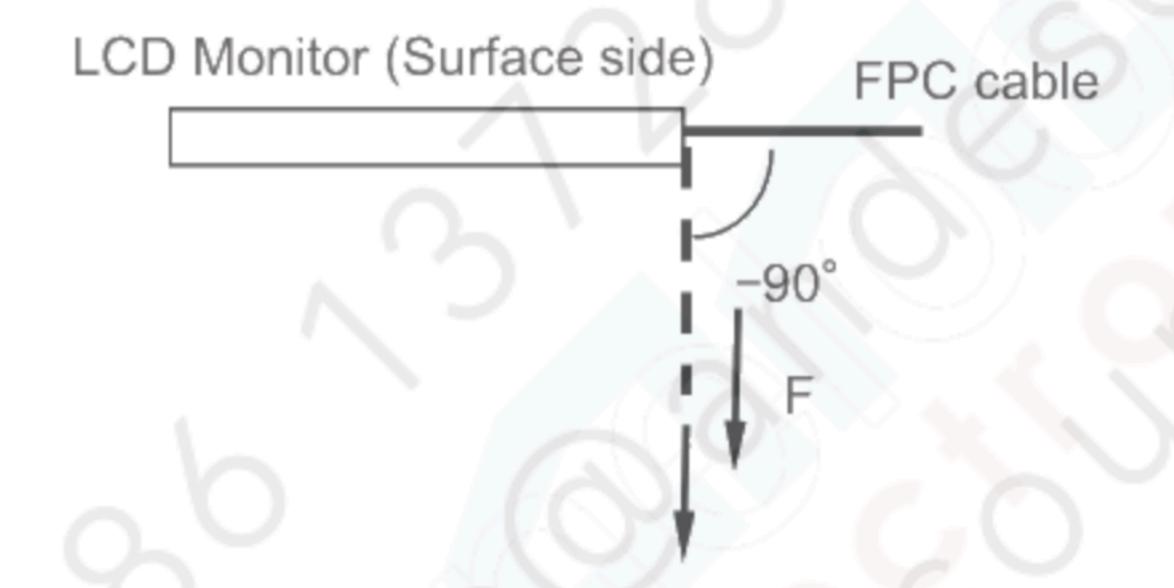
TOPPAN PRINTING CO.,LTD.

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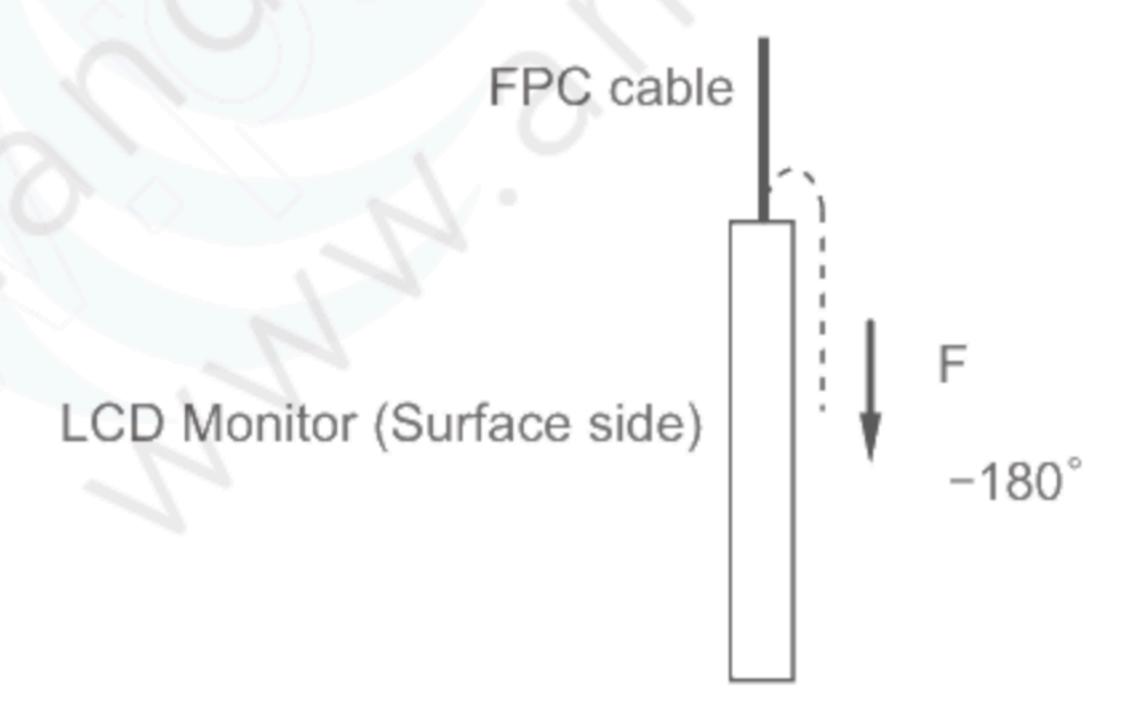
TOPPAN PRINTING Original Jig



Tension Test Method for FPC cable

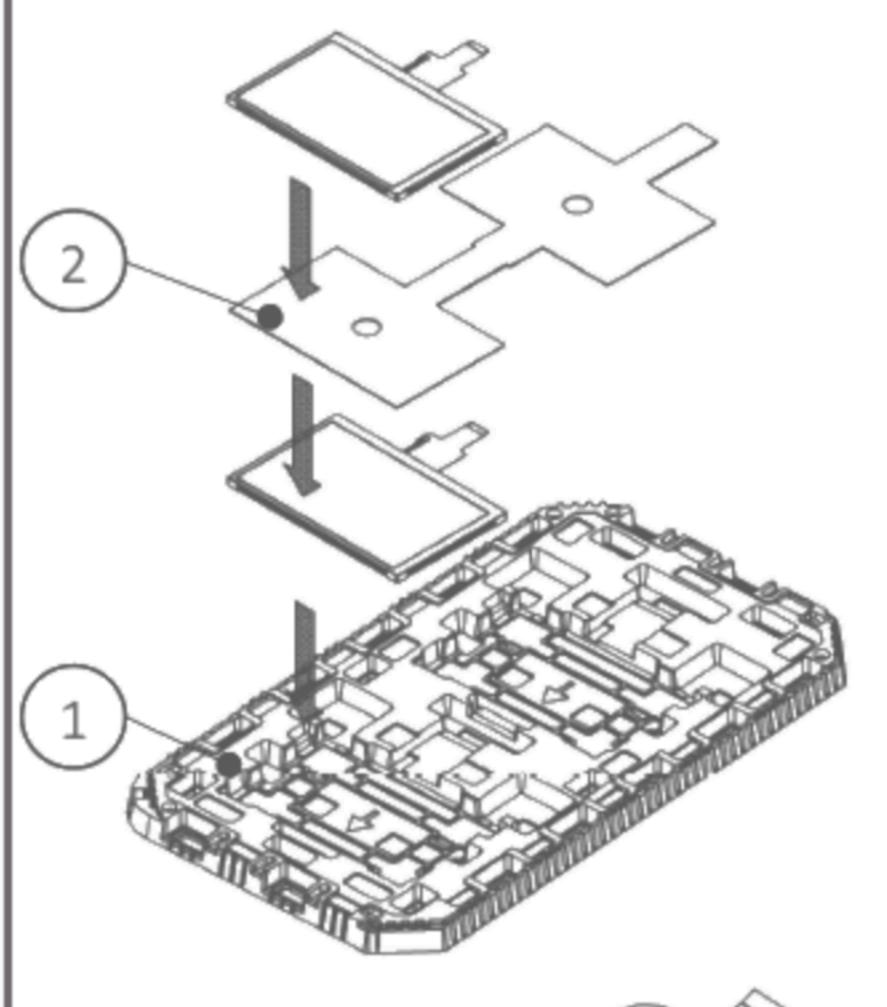


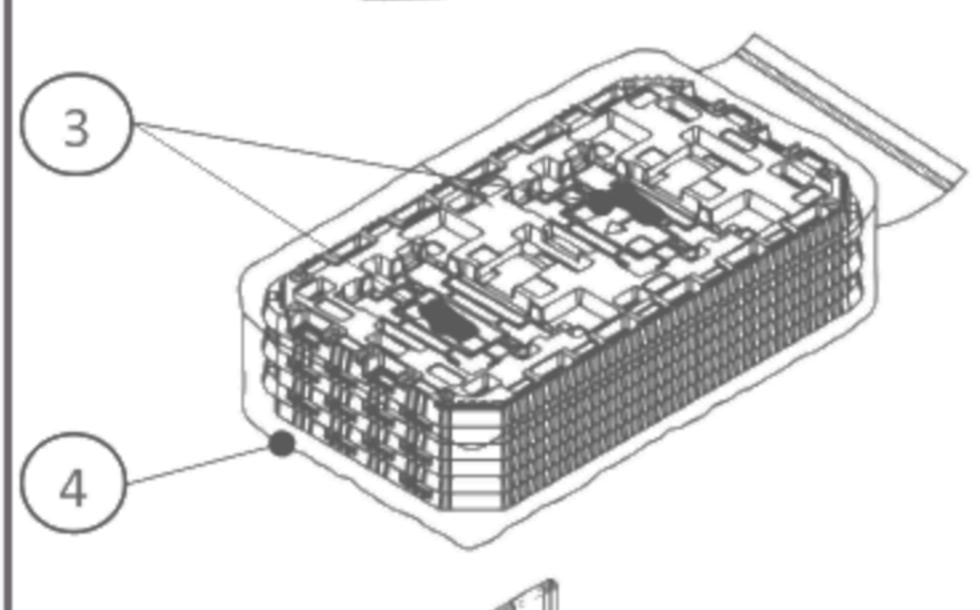
Bend Test Method for FPC cable

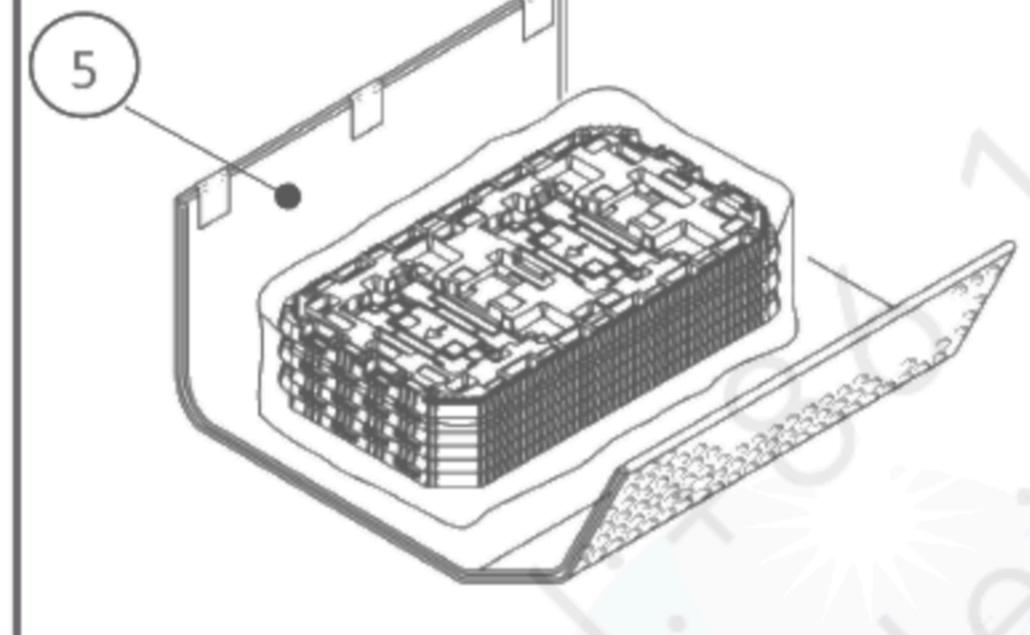


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Packing Specifications







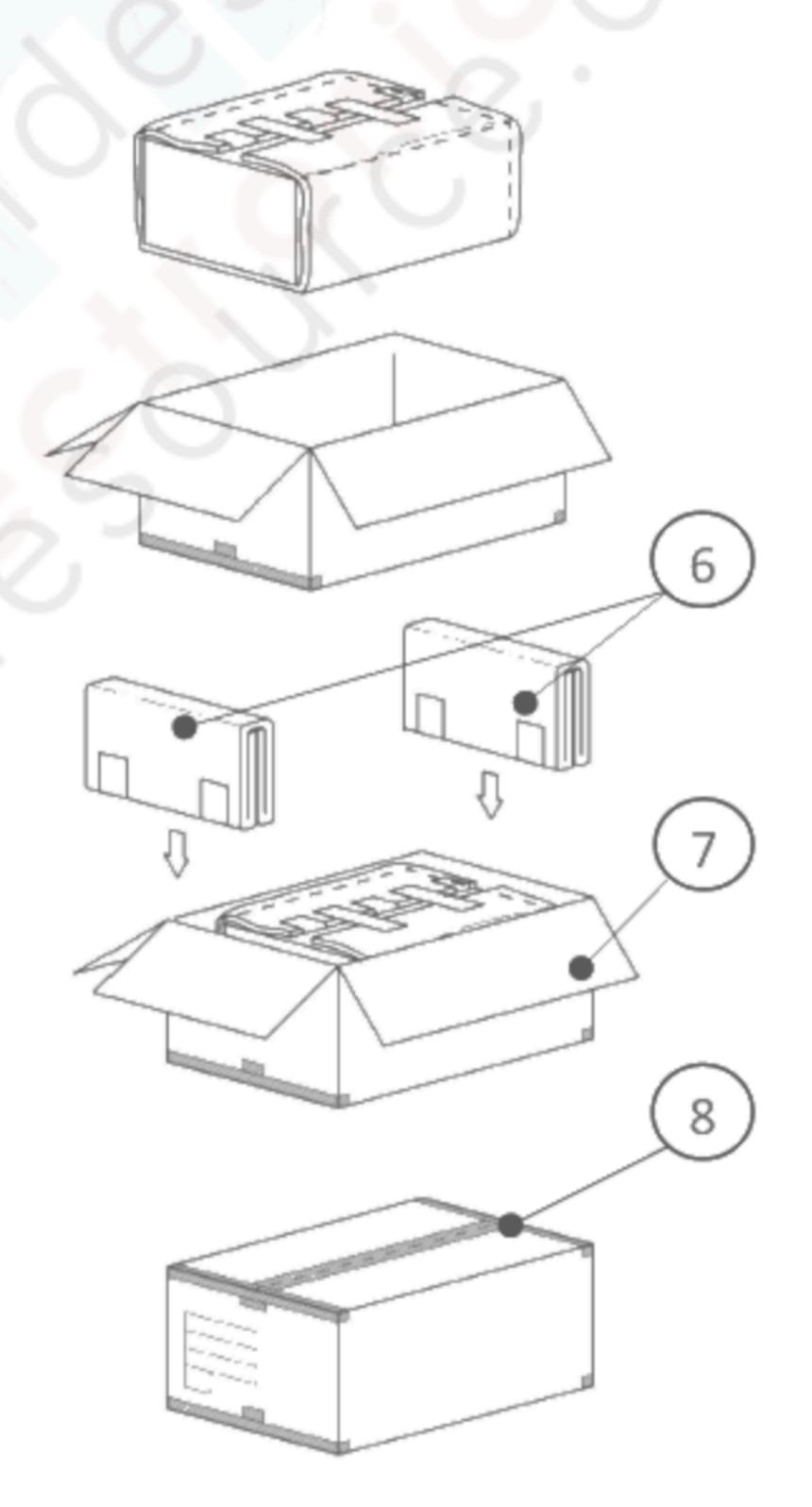
- Step1. Each product is to be placed in one of the cut-outs of the tray with the display surface facing upward. (2products per tray)

 Foam sheet is to be placed on the products in the tray.

 Each product is to be placed in one of the cut-outs of the tray with the display surface facing upward.(4products per tray)
- Step 2. The trays be in a stack of 5.(Rotate 180 degrees for each step)

 One empty tray is to be put on the top of stack of 5 trays.
- Step3. 2 packs of moisture absorbers are to be placed on the top tray as shown in the drawing. Put piled trays into a sealing bag.
- Step4. Vacuum and seal the sealing bag with the vacuum sealing machine.
- Step5. The stack of trays in the sealing bag is to be wrapped with a bubble cushioning sheet.
- Step6. The wrapped trays are placed in the outer carton.
- Step7. Bubble cushioning sheets are to be inserted into the outer carton with same orientation. The outer carton is to be sealed in H-shape with packing tape as shown in the drawing.
- Step8. The model number, quantity of products, and shipping date are to be printed on the outer carton.

 If necessary, shipping labels or impression markings are to be put on the outer carton.



Remark: The return of packing materials is not required.

	Packing item name	Specs., Material
1	Tray	A-PET
2	Foam sheet	Anti-static polyethylene
3	Drier	Moisture absorber
1	Sealing bag	
(5)	B SHEET C	Antistatic air babble sheet
6	B SHEET D	Antistatic air babble sheet
7	Outer carton	Corrugated cardboard
8	Packing tape	

Dimension	n of outer carton	
D : Approx.	(356mm)	
W: Approx.	(664mm)	
H: Approx.	(182mm)	
Quantity of products pa	acked in one carton:	20
Gross weight: A	pprox.	TBD

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13. Handling Instruction

13.1 Cautions for Handling LCD panels



Caution

- Do not make an impact on the LCD panel glass because it may break and you may get injured from it. (1)
- (2)If the glass breaks, do not touch it with bare hands. (Fragment of broken glass may stick you or you cut yourself on it.
- (3)If you get injured, receive adequate first aid and consult a medial doctor.
- Do not let liquid crystal get into your mouth. (4)(If the LCD panel glass breaks, try not let liquid crystal get into your mouth even toxic property of liquid crystal has not been confirmed.)
- If liquid crystal adheres, rinse it out thoroughly. (5)(If liquid crystal adheres to your cloth or skin, wipe it off with rubbing alcohol or wash it thoroughly with soap. If liquid crystal gets into eyes, rinse it with clean water for at least 15 minutes and consult an eye doctor.
- If you scrap this products, follow a disposal standard of industrial waste (6)that is legally valid in the community, country or territory where you reside.
- Do not connect or disconnect this product while its application products is powered on. (7)
- Do not attempt to disassemble or modify this product as it is precision component. (8)
- If a part of soldering part has been exposed, and avoid contact (short-circuit) (9)with a metallic part of the case etc. about FPC of this model, please. Please insulate it with the insulating tape etc. if necessary. The defective operation is caused, and there is a possibility to generation of heat and the ignition.
- Since excess current protection circuit is not built in this TFT module, there is the possibility that LCD module or peripheral circuit become feverish and burned in case abnormal operation is generated. We recommend you to add excess current protection circuit to power supply.
- The devices on the FPC are damageable to electrostatic discharge, because the terminals of the devices are exposed. Wear grounded wrist-straps and use electrostatic neutralization blowers to prevent static charge and discharge when handling the TFT monitors. Designate an appropriate operating area, and set equipment, tools, and machines properly when handling this product.



Caution

This mark is used to indicate a precaution or an instruction which, if not correctly observed, may result in bodily injury, or material damages alone.

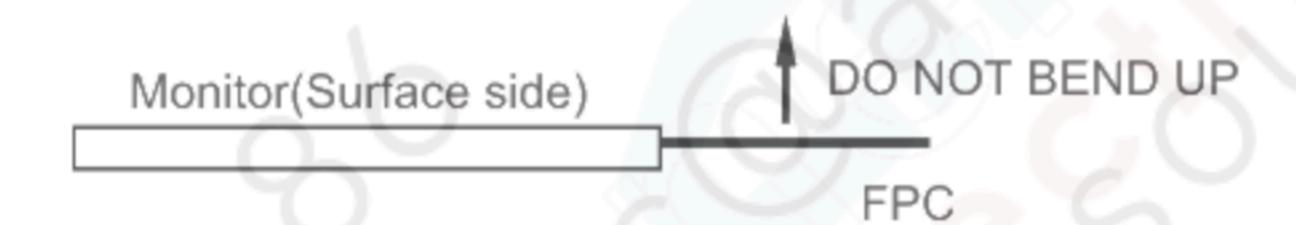
(ZII3Z)

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13.2 Precautions for Handling

- Wear finger tips at incoming inspection and for handling the TFT monitors to keep display quality and keep the working area clean.
 Do not touch the surface of the monitor as it is easily scratched.
- Wear grounded wrist-straps and use electrostatic neutralization blowers to prevent static charge and discharge when handling the TFT monitors as the LED in this TFT monitors is damageable to electrostatic discharge. Designate an appropriate operating area, and set equipment, tools, and machines properly when handling this product.
- 3) Avoid strong mechanical shock including knocking, hitting or dropping to the TFT monitors for protecting their glass parts. Do not use the TFT monitors that have been experienced dropping or strong mechanical shock.
- 4) Do not use or storage the TFT monitors at high temperature and high humidity environment. Particularly, never use or storage the TFT monitors at a location where condensation builds up.
- 5) Avoid using and storing TFT monitors at a location where they are exposed to direct sunlight or ultraviolet rays to prevent the LCD panels from deterioration by ultraviolet rays.
- 6) Do not stain or damage the contacts of the FPC cable.
 FPC cable needs to be inserted until it can reach to the end of connector slot.
 During insertion, make sure to keep the cable in a horizontal position to avoid an oblique insertion.
 Otherwise, it may cause poor contact or deteriorate reliability of the FPC cable.
- 7) Do not bend or pull the FPC cable or carry the TFT monitor by holding the FPC cable. Especially, it will cause mechanical damage or critical defect if FPC is pull up or bent up to short of display.



Peel off the protective film on the TFT monitors during mounting process. Refer to the section 13.5 on how to peel off the protective film. We are not responsible for electrostatic discharge failures or other defects occur when peeling off the protective film.

13.3 Precautions for Operation

- Since this TFT monitors are not equipped with light shielding for the driver IC,
 do not expose the driver IC to strong lights during operation as it may cause functional failures.
- In case of powering up or powering off this LCD module,
 be sure to comply the sequence as instructed in this specification.
- Do not plug in or out the FPC cable while power supply is switch on.
 Plug the FPC cable in and out while power supply is switched off.
- Do not operate the TFT monitors in the strong magnetic field. It may break the TFT monitors.
- Do not display a fixed image on the screen for a long time.
 Use a screen-saver or other measures to avoid a fixed image displayed on the screen for a long time.
 Otherwise, it may cause burn-in image on the screen due the characteristics of liquid crystal.

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13.4 Storage Condition for Shipping Cartons

Storage environment

Temperature 0 to 40°C
 Humidity 60%RH or less

No-condensing occurs under low temperature with high humidity condition.

Atmosphere No poisonous gas that can erode electronic components and/or

wiring materials should be detected.

Time period 1 year

Unpacking To prevent damages caused by static electricity, anti-static precautionary measures

(e.g. earthing, anti-static mat) should be implemented.

After unpack, keep product in the appropriate condition,

otherwise bubble seal of Protective film may be printed on Polarizer.

Maximum piling up 7 cartons

*Conditions to storage after unpacking

Storage environment

Temperature 0 to 40°C
 Humidity 60%RH or less

No-condensing occurs under low temperature with high humidity condition.

Atmosphere No poisonous gas that can erode electronic components and/or

wiring materials should be detected.

Time period 1 year (Shelf life)

Others
 Keep/ store away from direct sunlight

Storage goods on original tray made by TOPPAN PRINTING.

13.5 Precautions for Peeling off the Protective film

The followings work environment and work method are recommended to prevent the TFT monitors from static damage or adhesion of dust when peeling off the protective films.

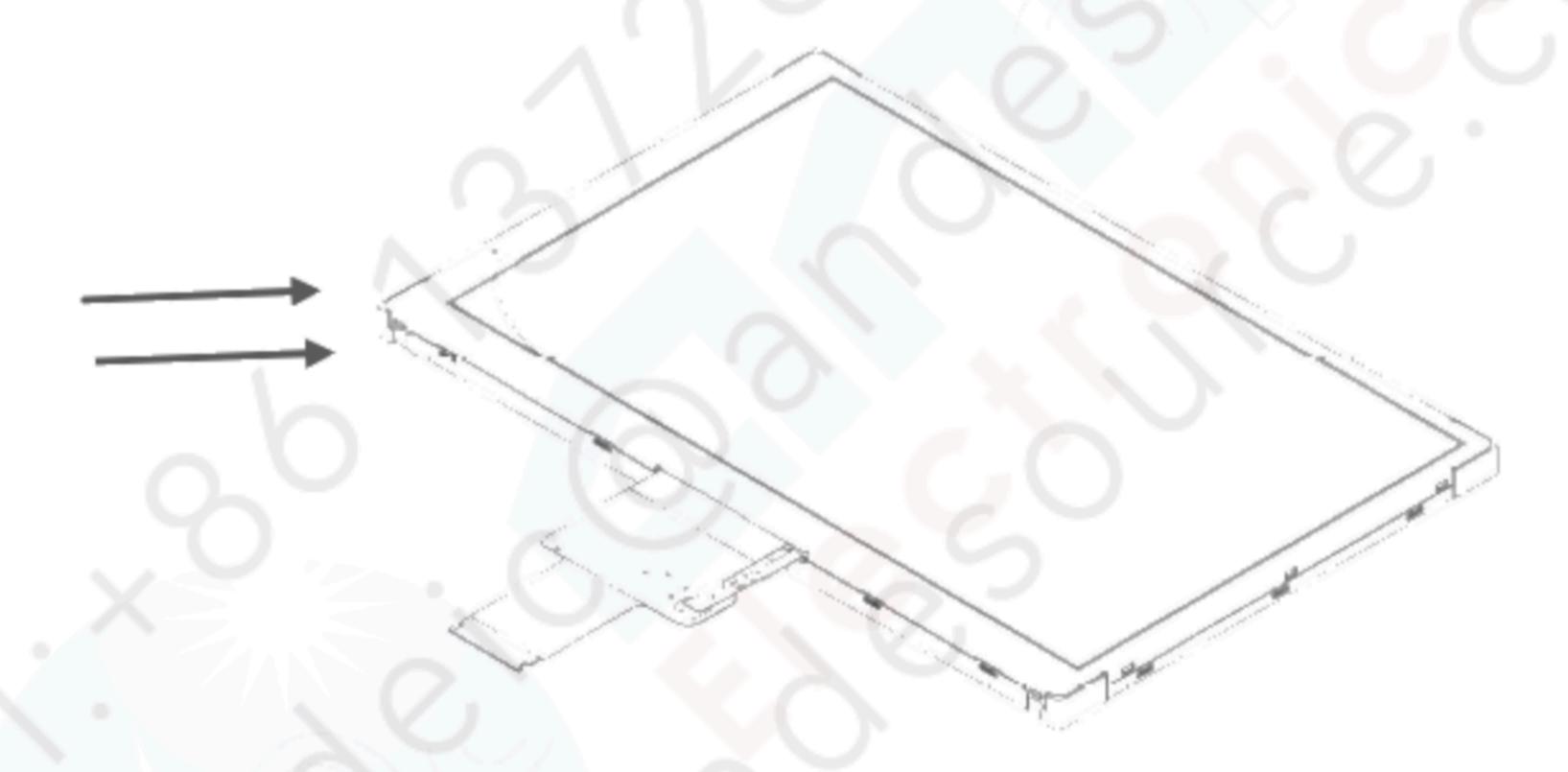
A) Work Environment

- a) Humidity: 50 to 70 %RH, Temperature15 to 27 °C
- b) Operators should wear conductive shoes, conductive clothes, conductive finger tips and grounded wrist-straps.
 Use an electrostatic neutralization blower.
 - Anti-static treatment should be implemented to work area's floor.
- c) Use a room shielded against outside dust with sticky floor mat laid at the entrance to eliminate dirt.

B) Work Method

The following procedures should taken to prevent the driver ICs from charging and discharging.

- a) Use an electrostatic neutralization blower to blow air on the TFT monitors to its lower left when FPC is placed at the bottom.
 Optimize direction of the blowing air and the distance between the TFT monitors and the electrostatic neutralization blower.
- b) Put an adhesive tape (Scotch tape, etc) at the lower left corner area of the protective film to prevent scratch on surface of TFT monitors.
- c) Peel off the adhesive tape slowly (spending more than 2 secs to complete) by pulling it to opposite direction.



Blower wind direction (Set an ion blower with its adequate conditions.)

13.6 Warranty

TOPPAN PRINTING is only liable to defective goods which is stored and used under the condition complying with this specifications and returned within 1 (one) year.

Warranty caused by manufacturing defect shall be conducted by replacement of goods or refundment at unit price.

APPENDIX

Reference Method for Measuring Optical Characteristics and Performance

1. Measurement Condition (Backlight ON)

Measuring instruments: CS2000 (KONICA MINOLTA), LCD7200 (OTSUKA ELECTRONICS), EZcontrast160D (ELDIM)

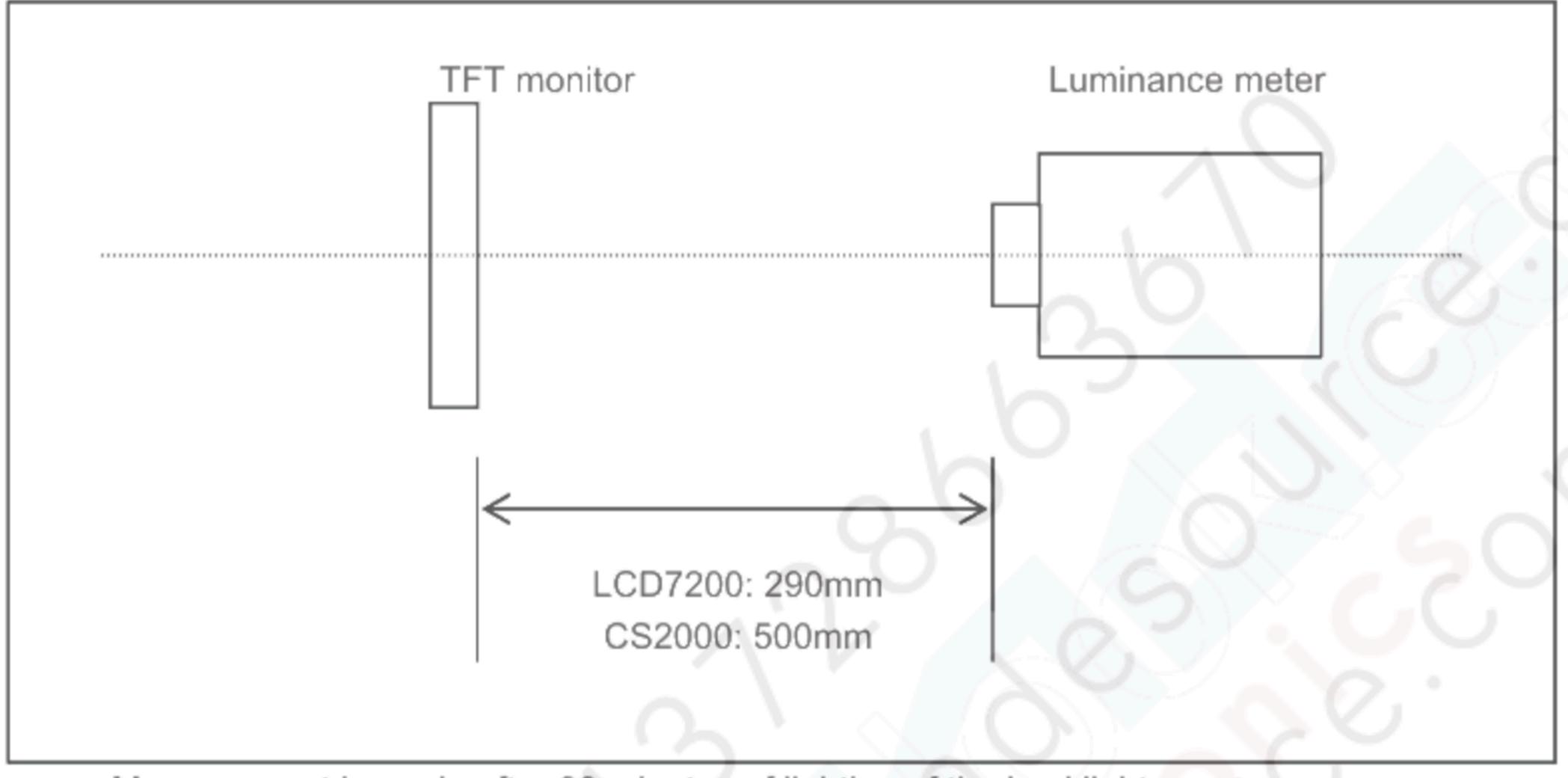
Driving condition: Refer to the section "Optical Characteristics"

Measured temperature: 25°C unless specified

Measurement system: See the chart below. The luminance meter is placed on the normal line of measurement system.

Measurement point: At the center of the screen unless otherwise specified

Dark box at constant temperature

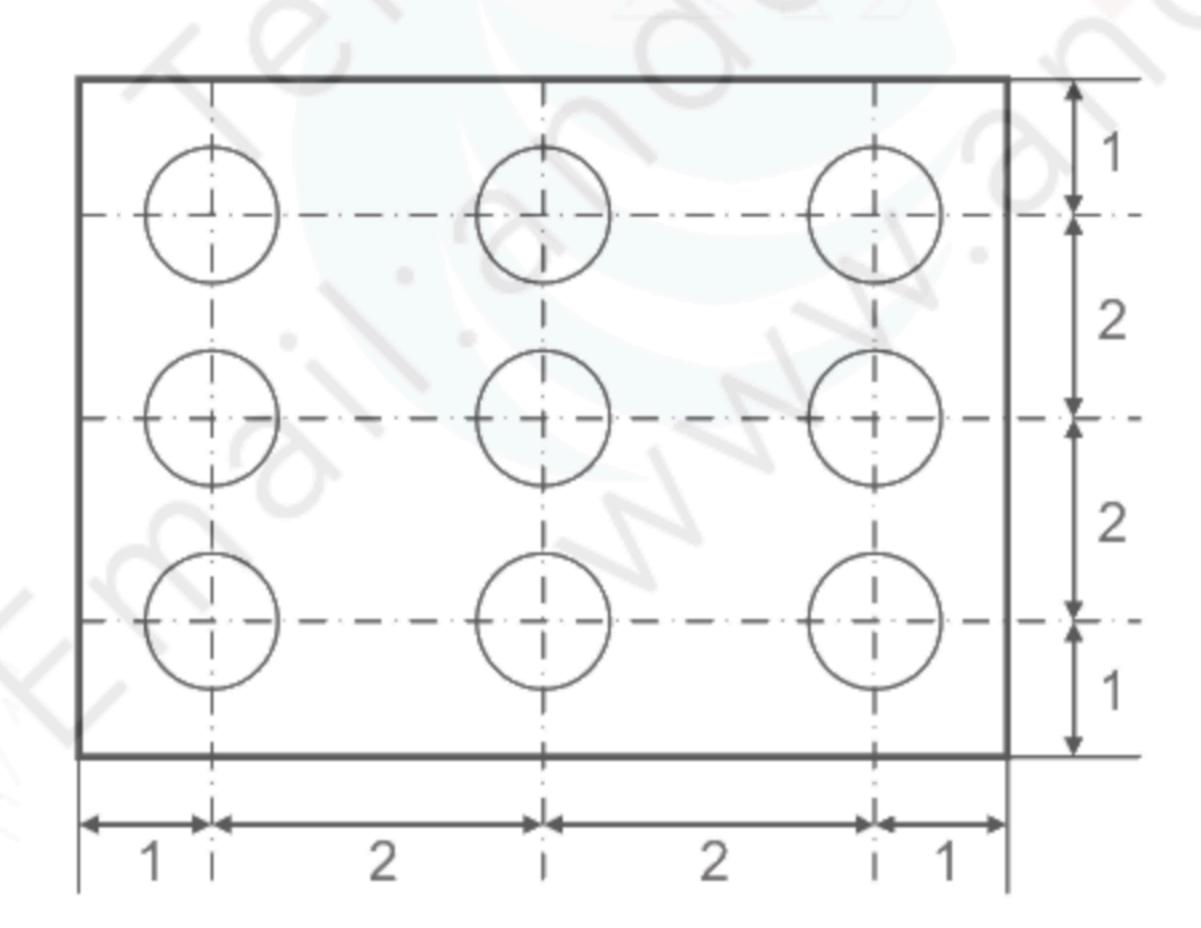


Measurement is made after 30 minutes of lighting of the backlight.

Measurement point: At the center point of the screen

Brightness distribution: 9 points shown in the following drawing.

<Landscape model>



Dimensional ratio of active area

Backlight IL1=IL2=(20)mA

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Measurement Condition (Contrast ratio Backlight OFF only)

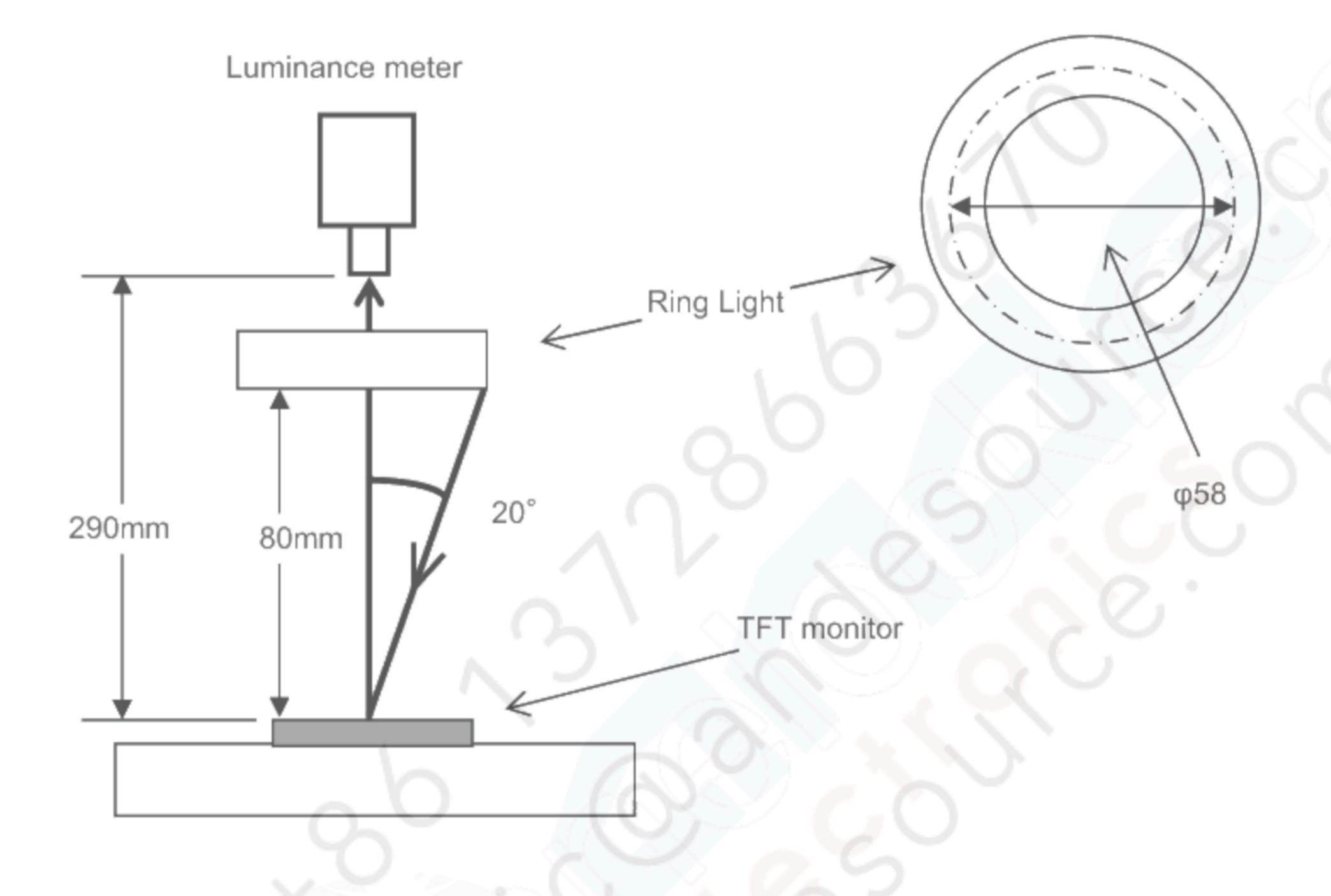
Measuring instruments: LCD7200(OTSUKA ELECTRONICS),Ring Light(40,000 lx,φ58)

Driving condition: Refer to the section "Optical Characteristics"

Measured temperature: 25°C unless specified

Measurement system: See the chart below.

Measurement point: At the center of the screen.



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2. Test Method

Votice	Item	Test method	Measuring instrument	Remark
1	Response	Measure output signal waves with a brightness meter when the raster or window pattern is changed over from white to black and from black to white	LCD7200	Black display [Data]=00h White display [Data]=FFh
		Black White Black		TON Rise time
		White brightness		TOFF Fall time
		10% 90% 10% 0% Black brightness TON TOFF		
2	Contrast ratio	Measure maximum luminance Y1([Data]=FFh) and minimum luminance Y2([Data]=00h) at the center of the screen by displaying raster or window pattern. Then calculate the ratio between these two values. Contrast ratio = Y1/Y2 Diameter of measuring point: 7.8mmφ(CS2000) Diameter of measuring point: 3mmφ(LCD7200)	CS2000 LCD7200	Backlight ON Backlight OFF
3	Viewing angle Horizontalθ Verticalφ	Move the luminance meter from right to left and up and down and determine the angles where contrast ratio is 10.	EZcontrast160D	
4	White	Measure chromaticity coordinates x and y of CIE1931 colorimetric system at [Data] = FFh Color matching function: 2°view Measurement angle: 1°	CS2000	
5	Burn-in	Visually check burn-in image on the screen		At optimized
6	Center	after 2 hours of "window display" ([Data]=00h/FFh). Measure the brightness at the center of the screen.	CS2000	VCOMDC
7	Brightness	(Brightness distribution) = 100 x B/A %	CS2000	